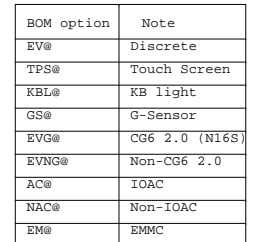
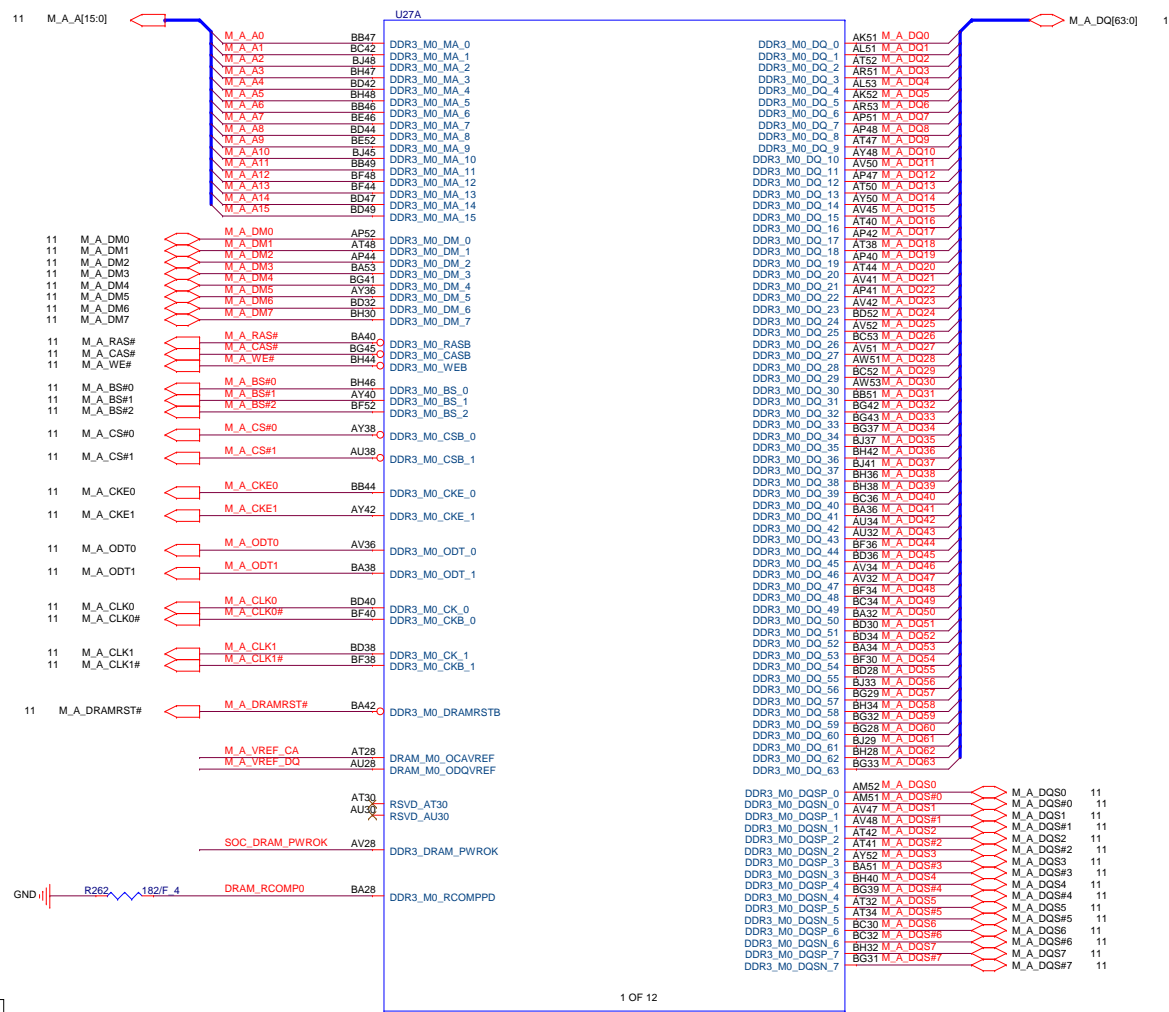


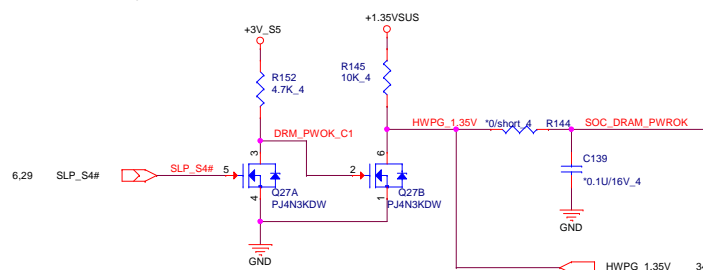
LAYER 1 : TOP
LAYER 2 : SVCC
LAYER 3 : IN1(High)
LAYER 4 : IN2(Low)
LAYER 5 : SGND
LAYER 6 : BOT

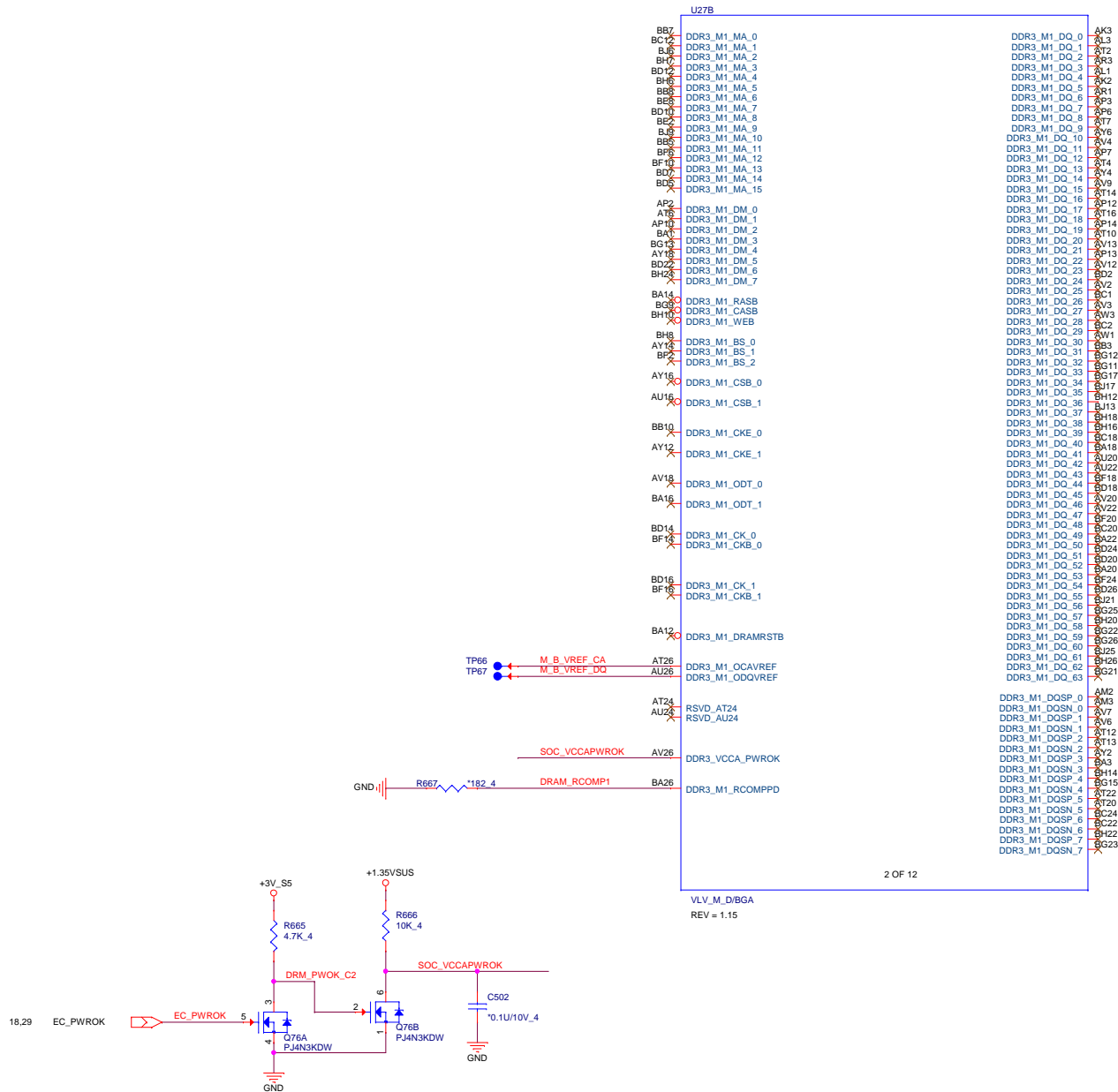


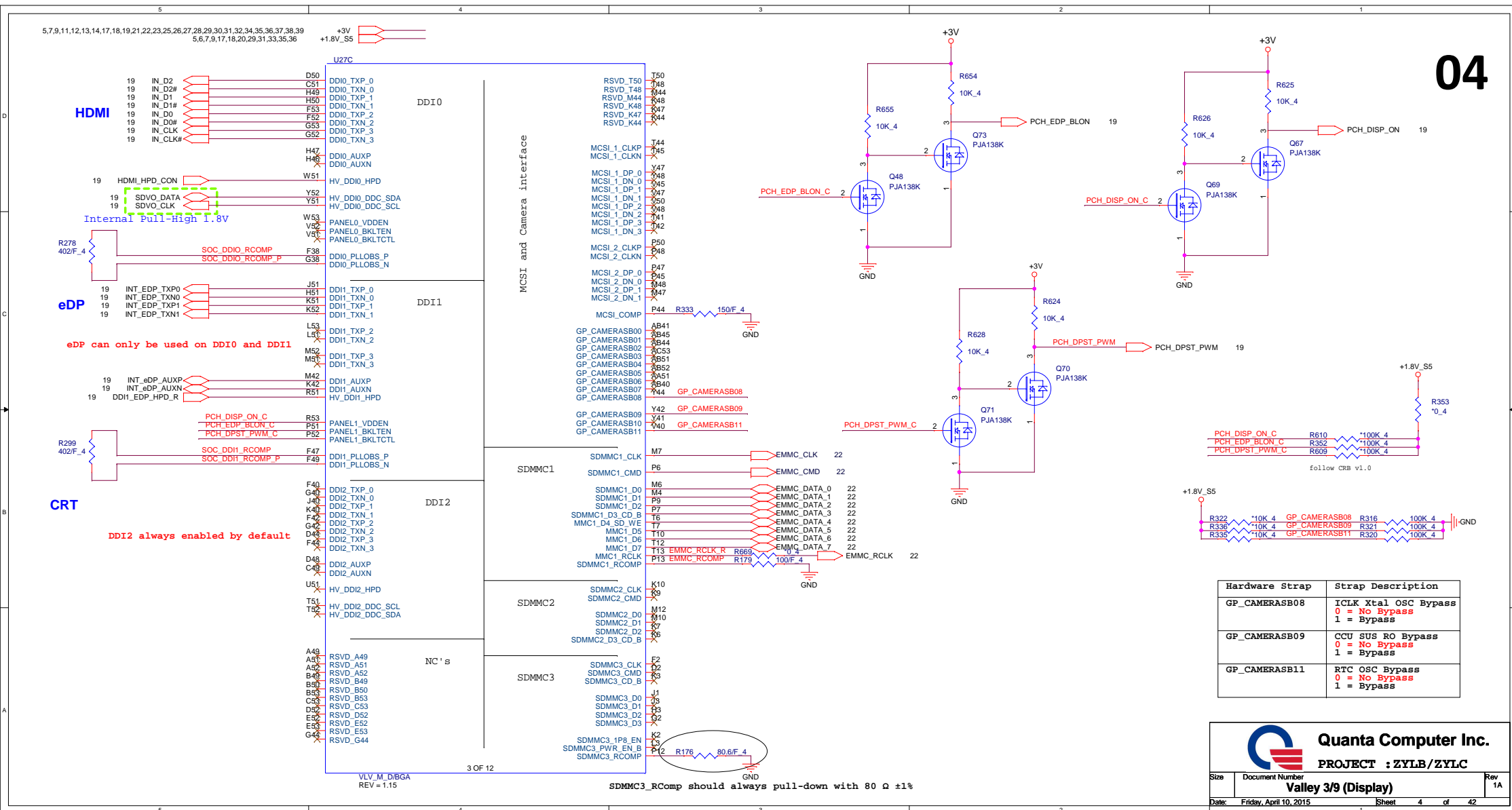


Channel 0	Channel 1	SoC Supported Memory Operation Speed
1333 MHz	X	1066 MHz
1600 MHz	X	1600 MHz
1333 MHz	1333 MHz	1066 MHz
1600 MHz	1600 MHz	1600 MHz

Channel 0 need to
be populated first for the platform to power on





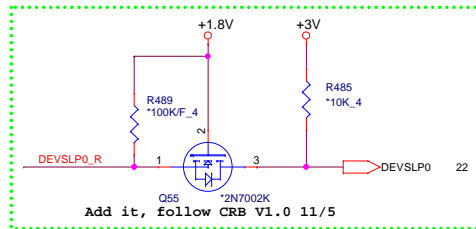
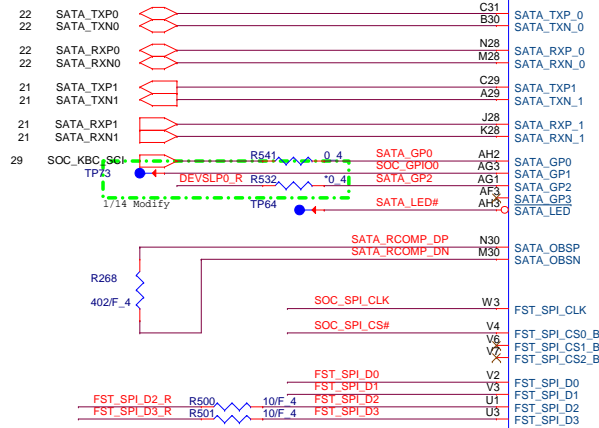


4,6,7,9,17,18,20,29,31,33,35,36
2,3,9,17,18,20,23,26,27,29,33,38

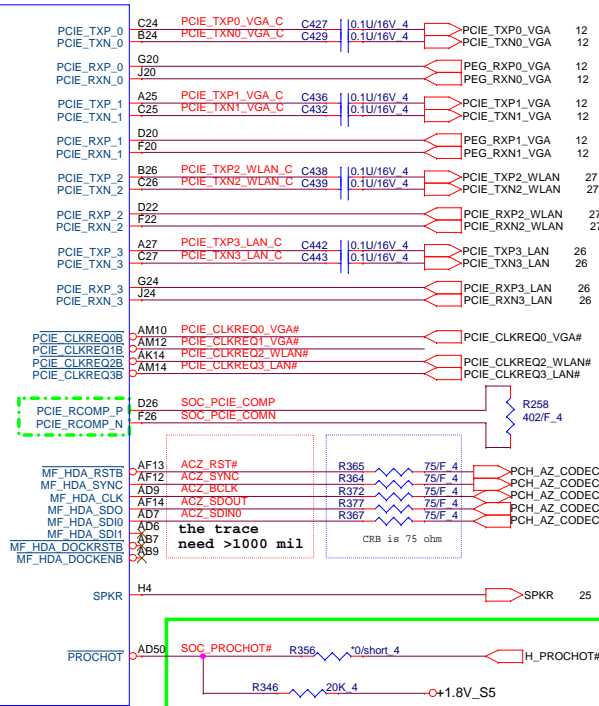
+1.8V_S5
+3V_S5

SATA HDD

SATA ODD



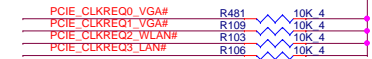
VLV_M_D/BGA
REV = 1.15
4 OF 12



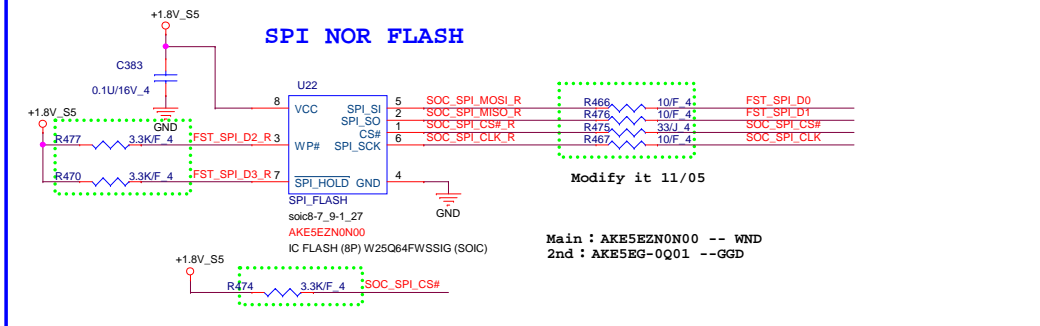
VGA N16 x2

WLAN x1

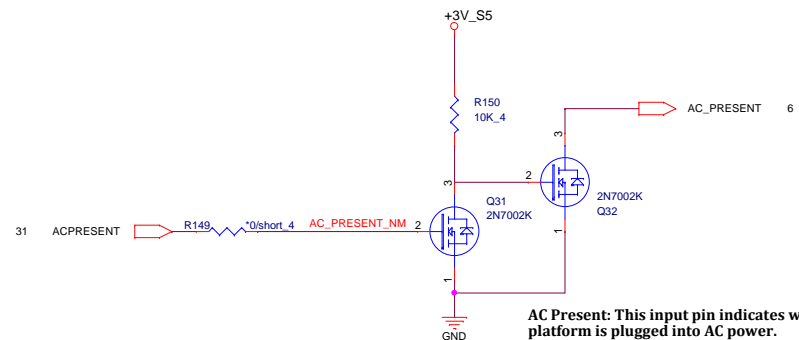
LAN x1



SPI NOR FLASH



Main : AKE5EZNON00 -- WND
2nd : AKE5EG-0Q01 --GGD

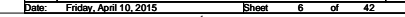


Quanta Computer Inc.

PROJECT : ZYL/PCIE/SATA

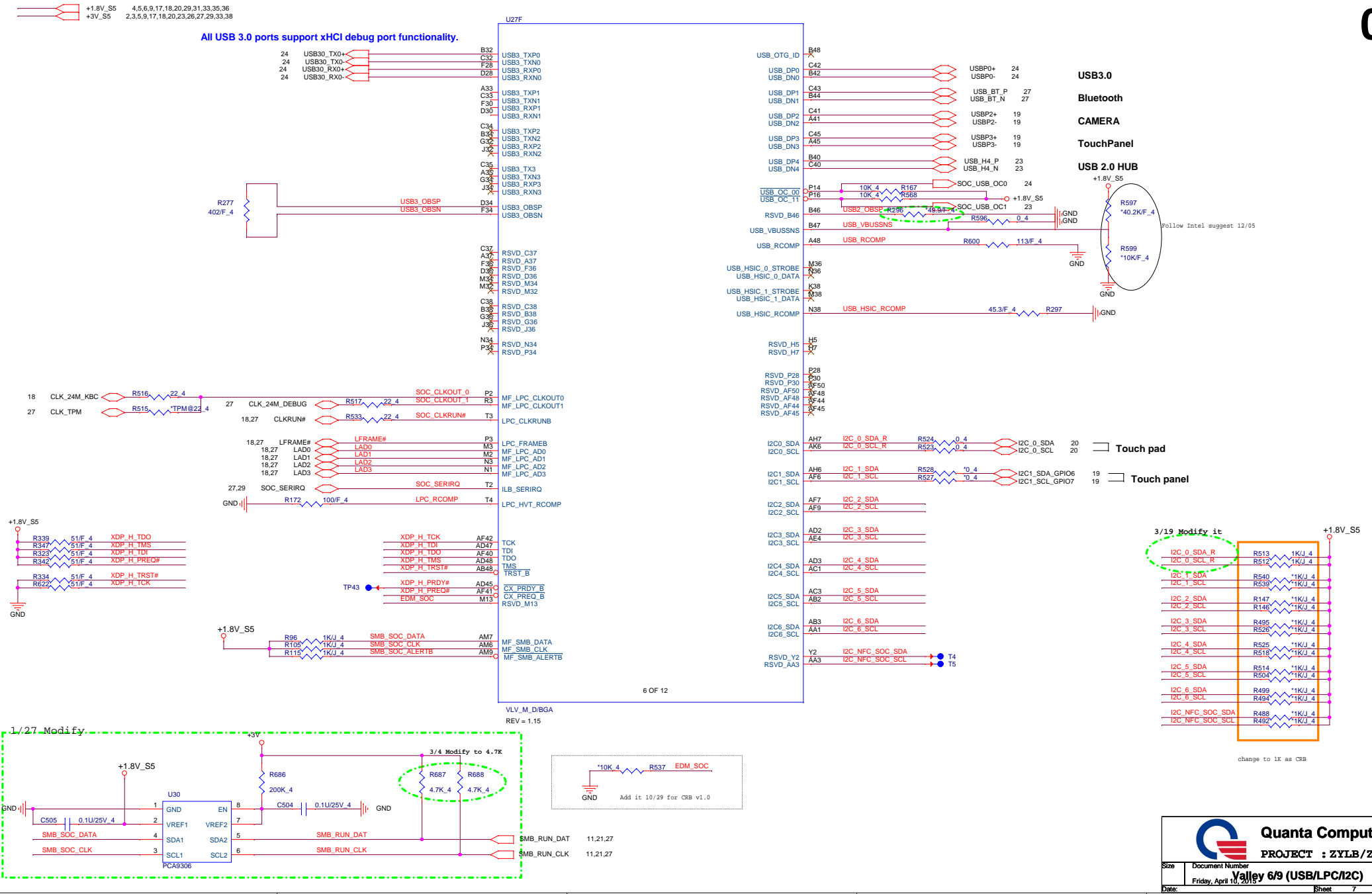
Valley 4/9 (SD/PCIE/SATA)

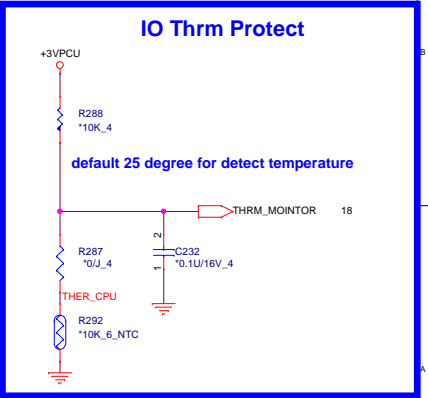
Size Document Number
Date: Friday, April 10, 2015
Sheet 5 of 42
Rev 1A

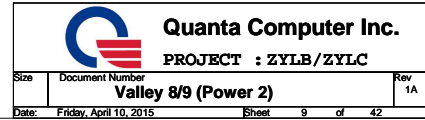


Date: Friday, April 10, 2015	Sheet 6 of 42
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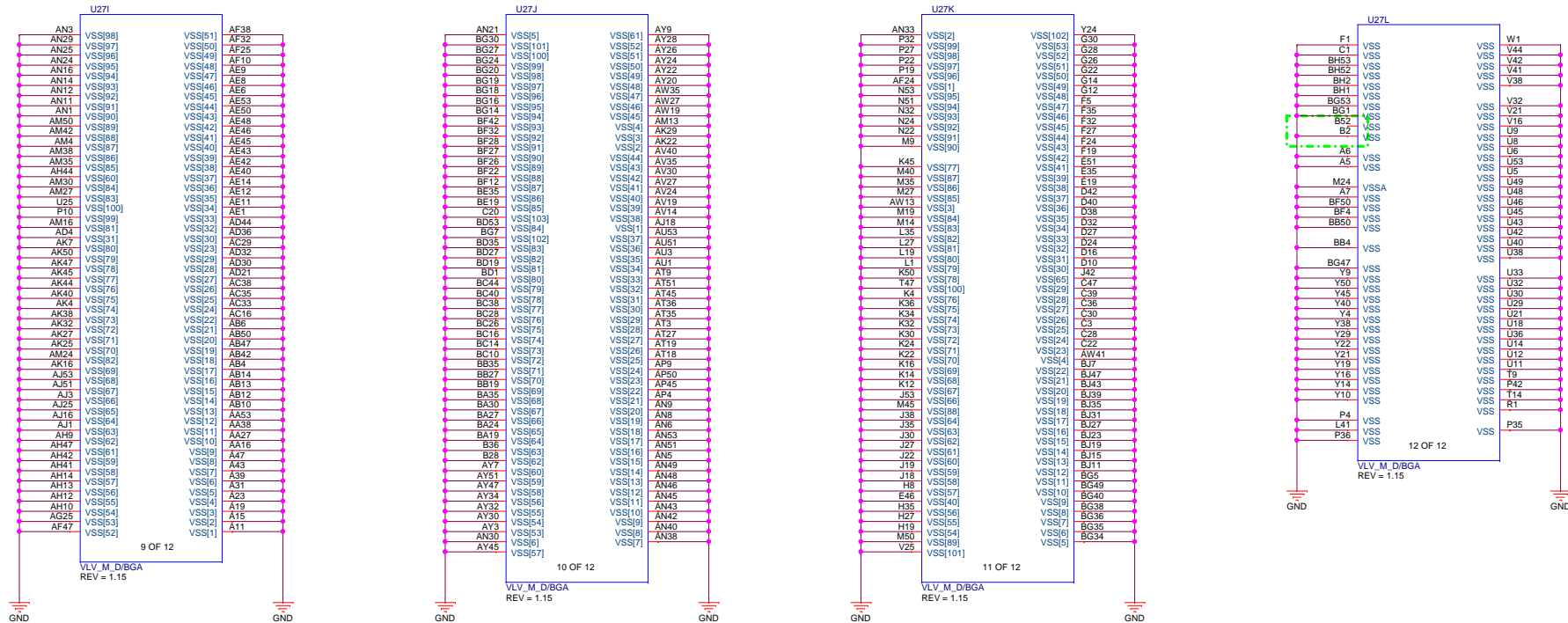
All USB 3.0 ports support xHCI debug port functionality.







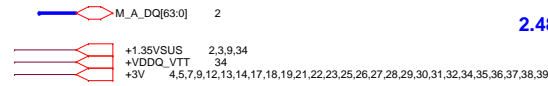
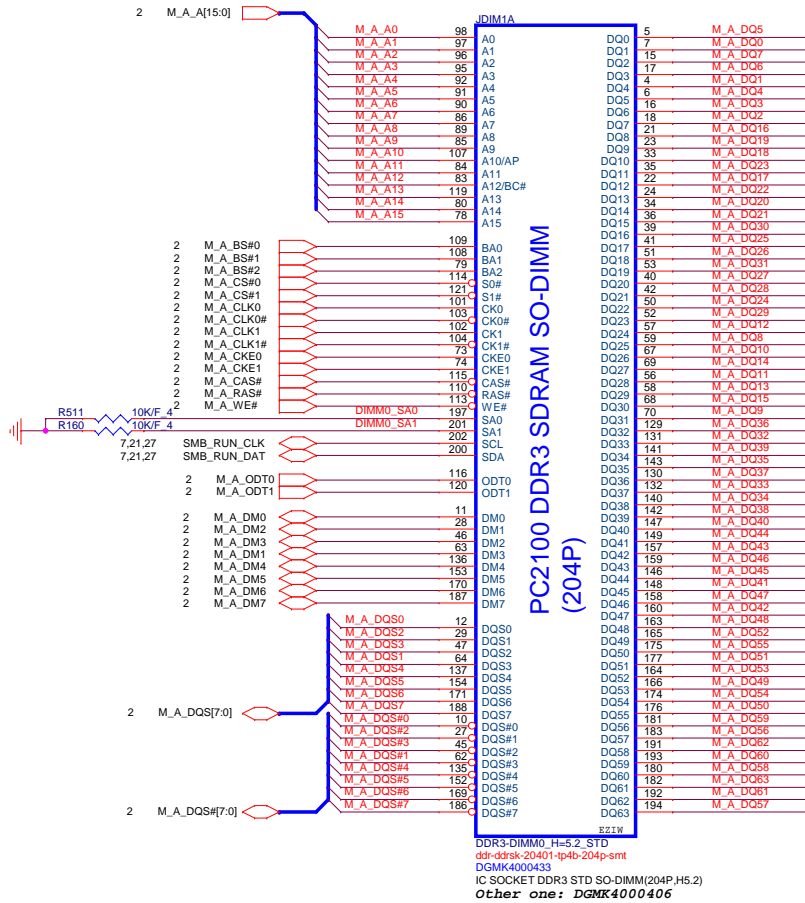
B52 is NC for layout issue



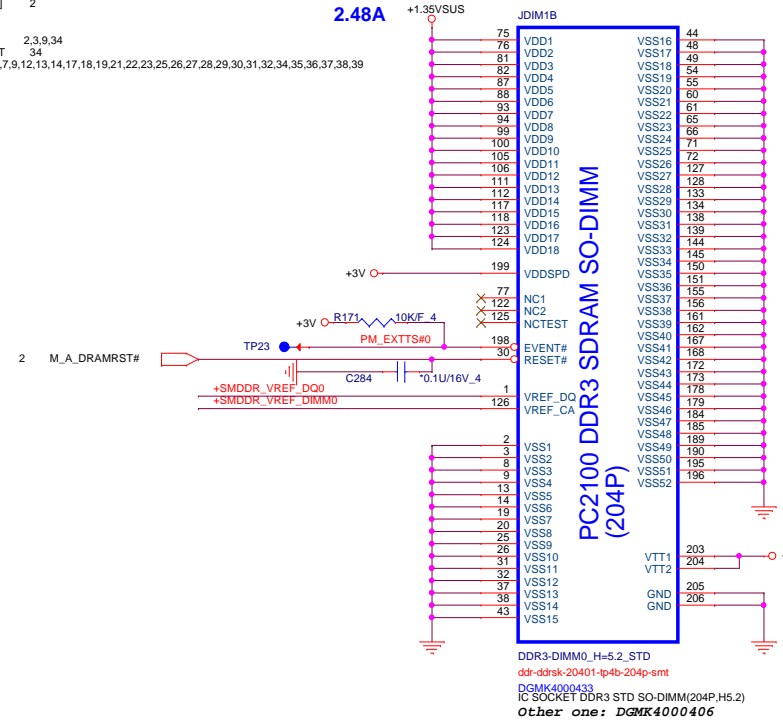
Quanta Computer Inc.
PROJECT : ZYLB/ZYLC

Size Document Number
Valley 9/9 (GND) Rev 1A

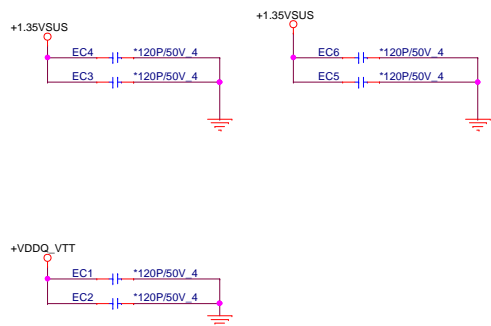
Date: Friday, April 10, 2015 Sheet 10 of 42



2.48A

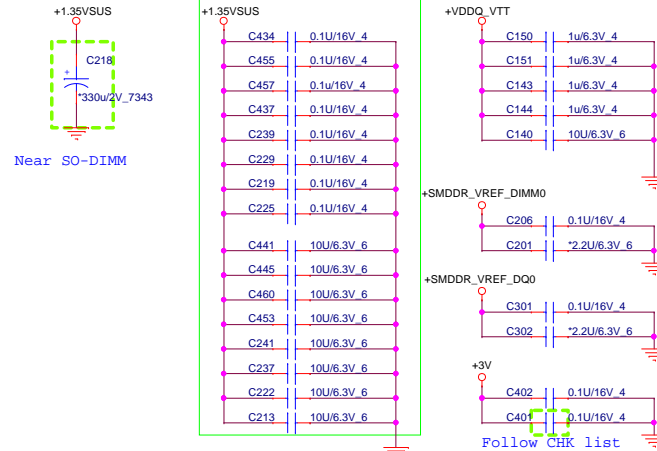


For EMI RESERVE

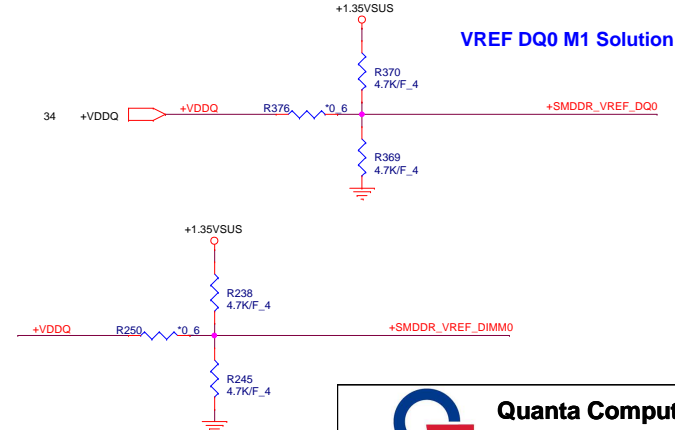


Place these Caps near So-Dimm0.

0.1uF/10uF 4pcs on each side of connector



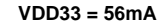
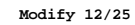
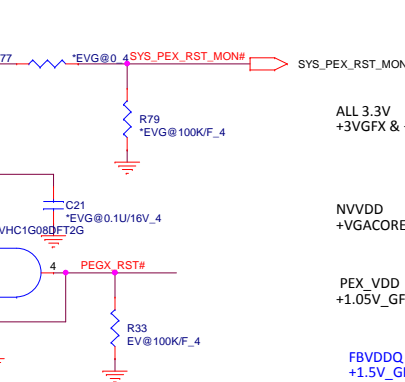
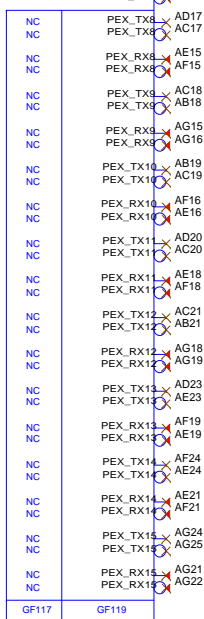
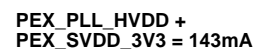
VREF DQ0 M1 Solution

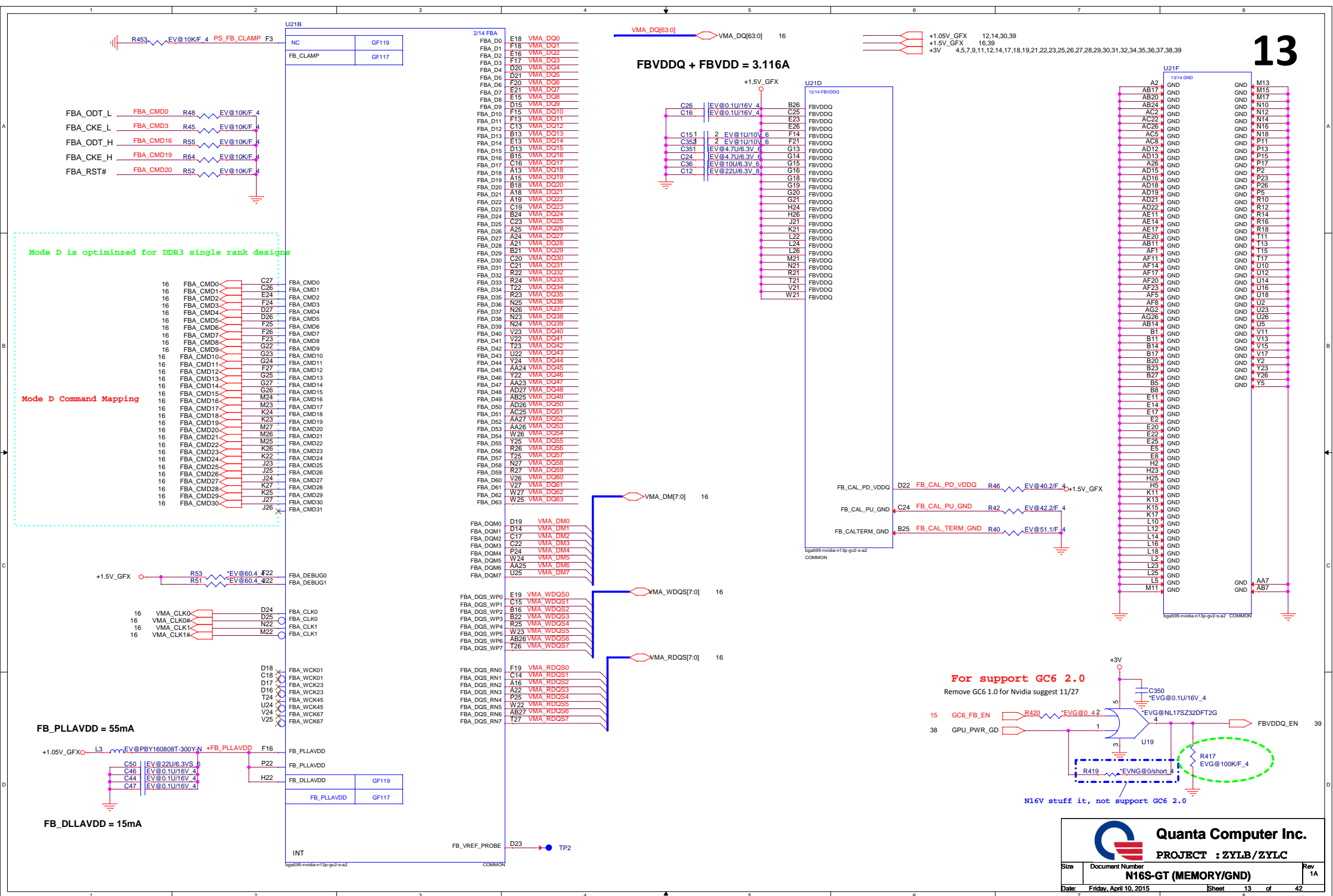


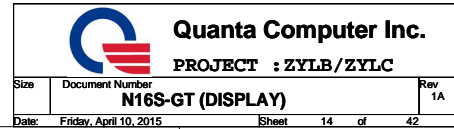
Quanta Computer Inc.

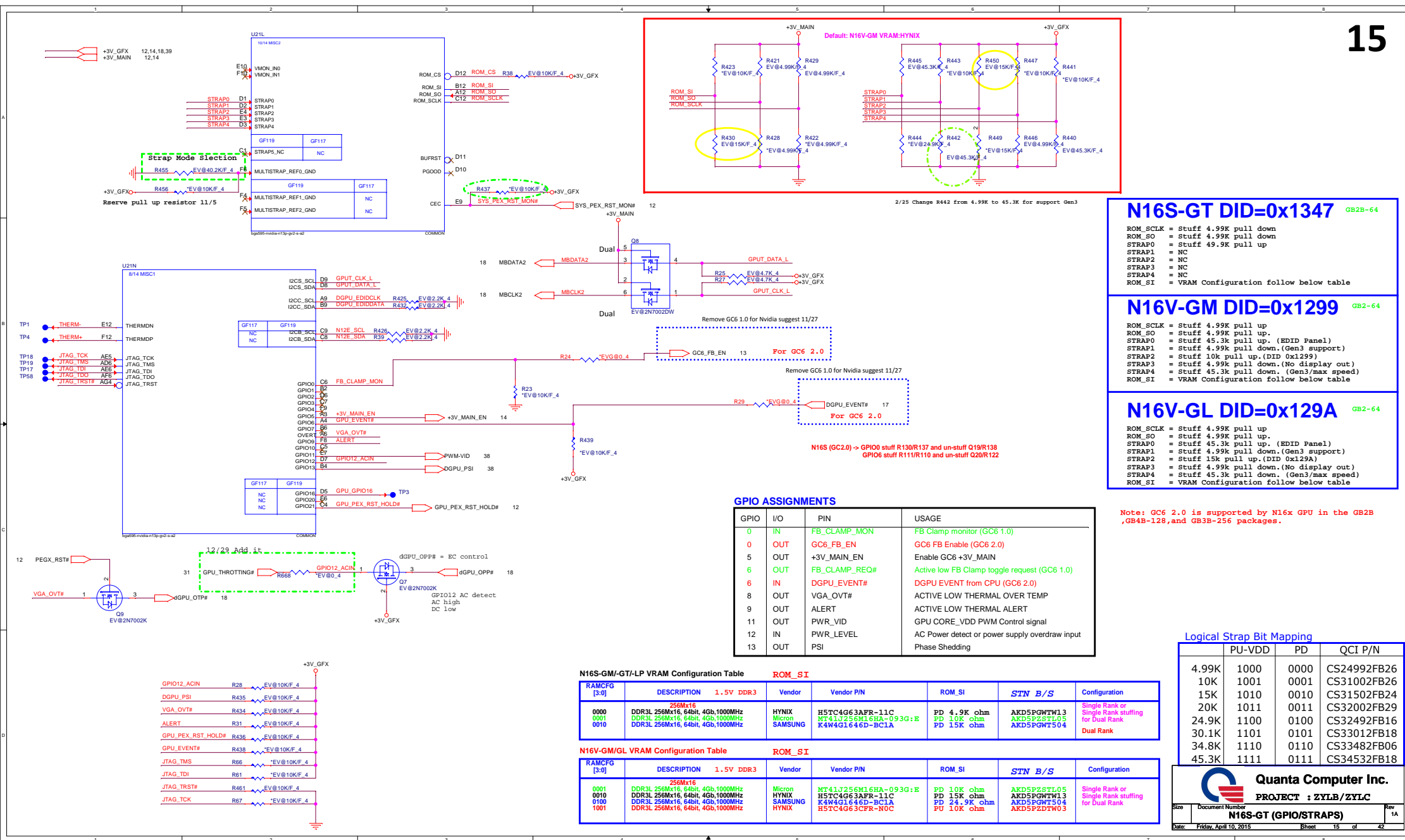
PROJECT : ZYLB/ZYLC

Size	Document Number	Rev
	DDR3 DIMM0-STD(5.2H)	1A
Date:	Friday, April 10, 2015	Sheet 11 of 42





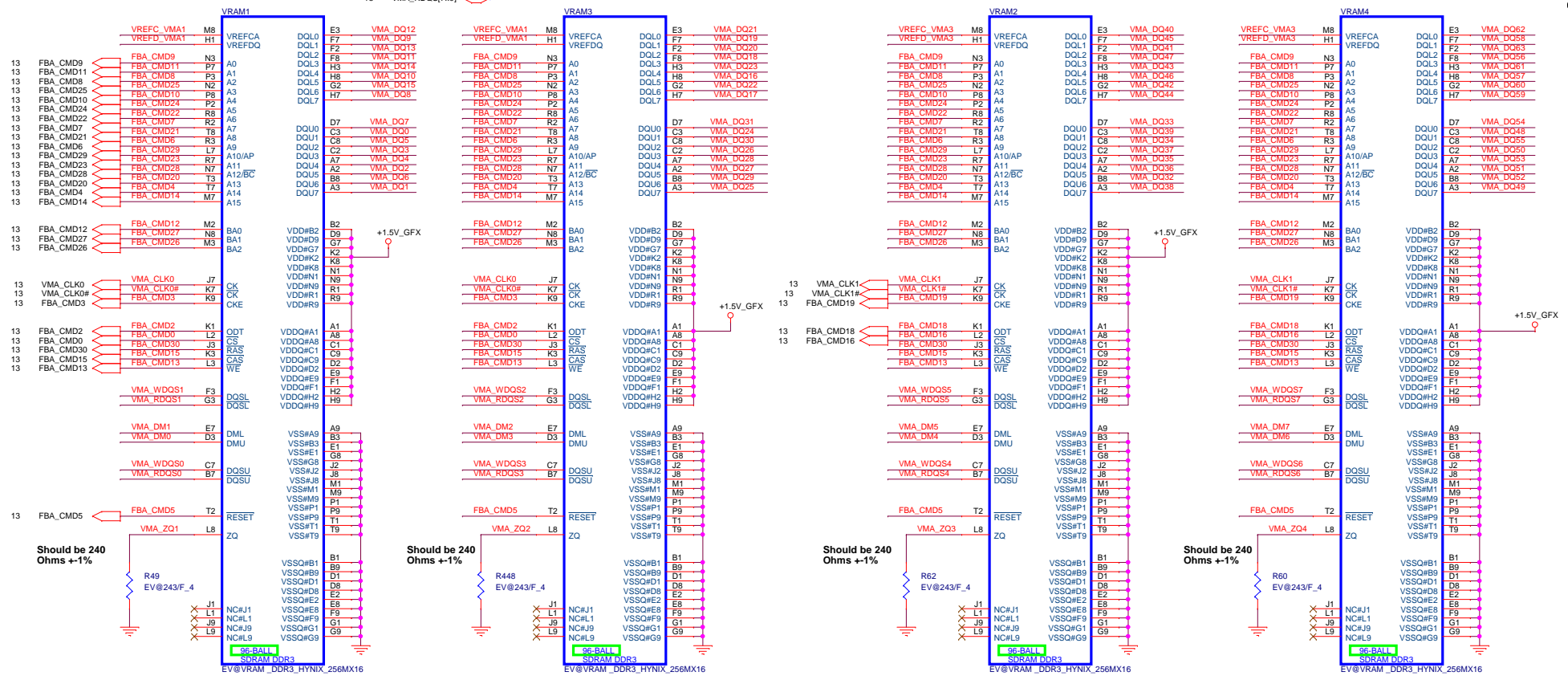




HYU 256Mx16, H5TC4G63AFR-11C STN B/S PN : AKD5PGWTW13
 MIC 256Mx16, MT41J256M16HA-093G:E STN B/S PN : AKD5PZSTL05
 SAM 256Mx16, K4W4G1646D-BC1A STN B/S PN : AKD5PGWT504

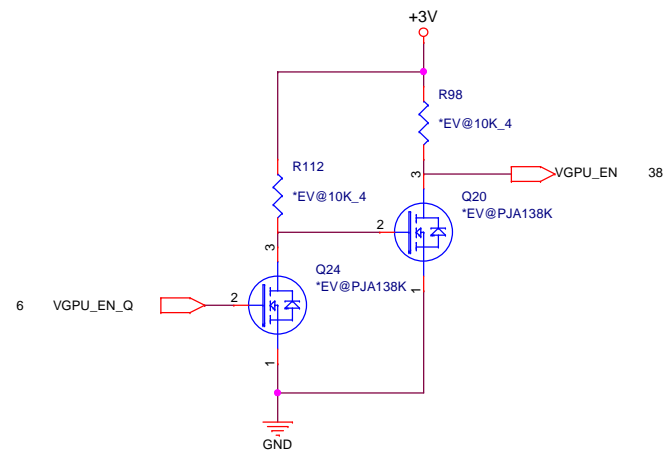
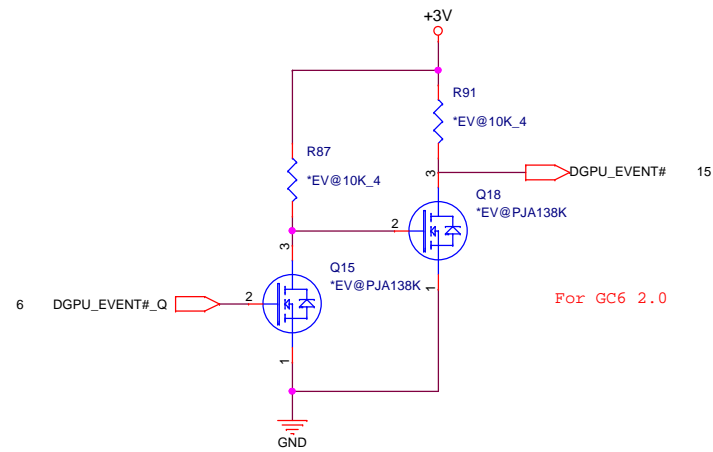
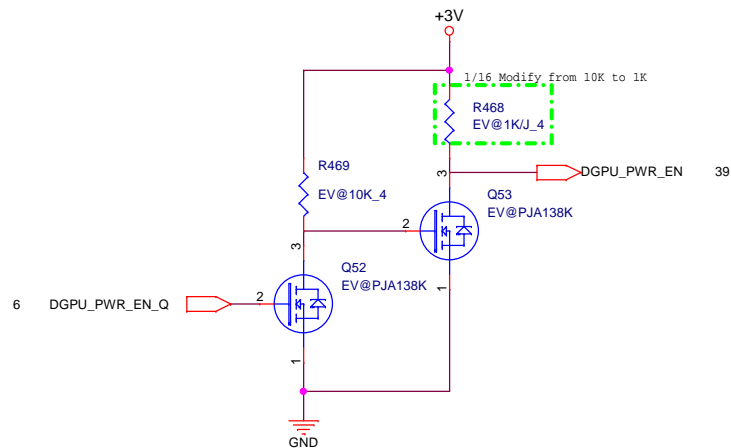
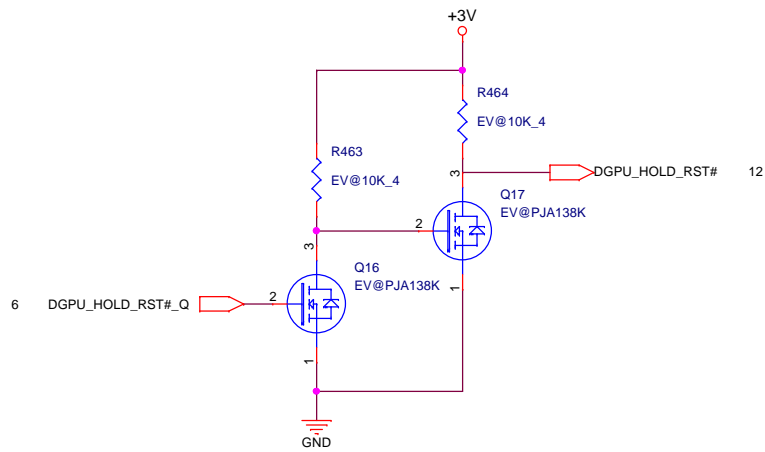
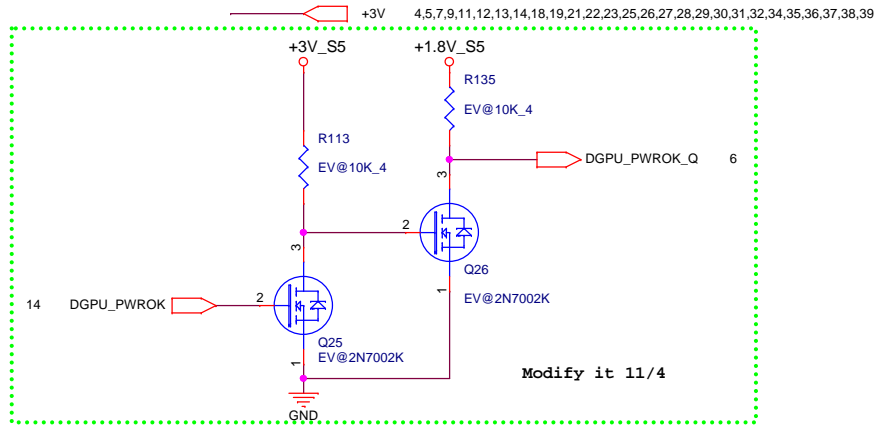
CHANNEL A: 2048MB DDR3X16

+1.05V_GFX 12,13,14,30,39
 +1.5V_GFX 13,39

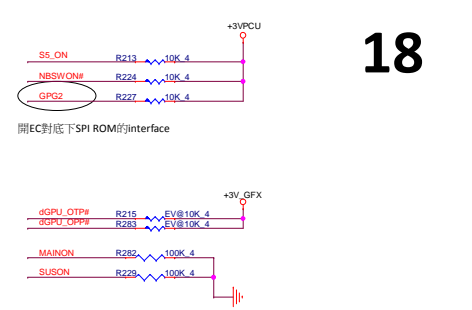


162 1% ohm
 CS11622FB07 RES CHIP 162 1/16W +-1%(0402)
 CS11622FB15 RES CHIP 162 1/16W +-1%(0402)

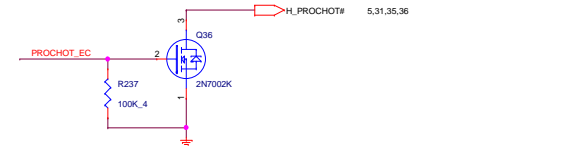
Fermi : Change to 160 ohm
 1 : CS11602JB00 ,RES CHIP 160 1/16W +-5%(0402)
 2 : CS11622FB07 ,RES CHIP 162 1/16W +-1%(0402)



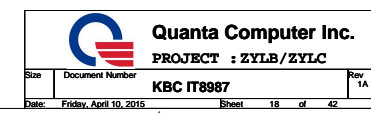
18

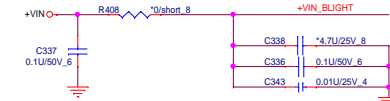
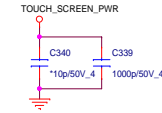
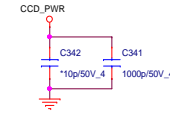
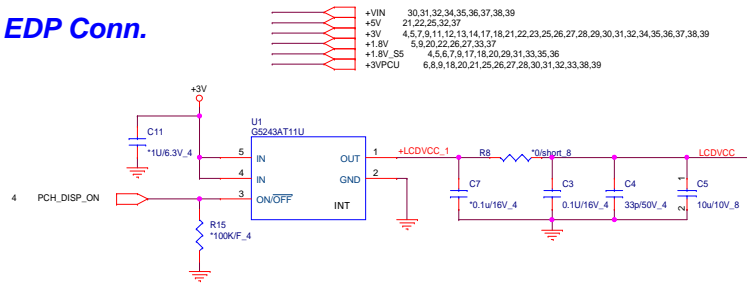
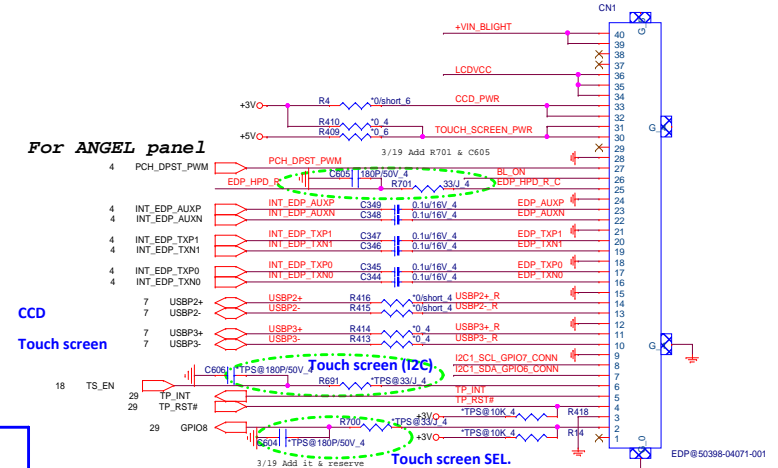
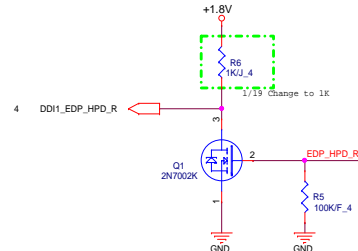
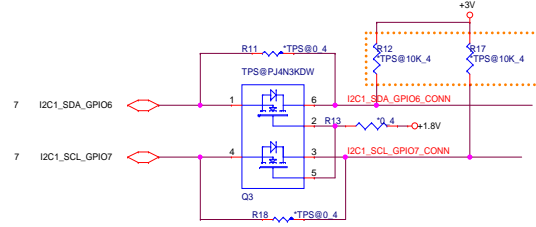
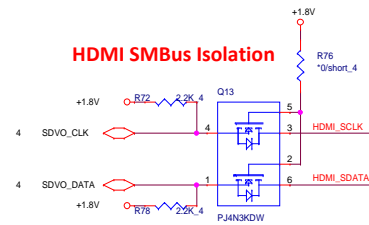
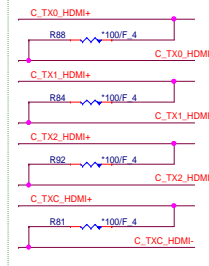
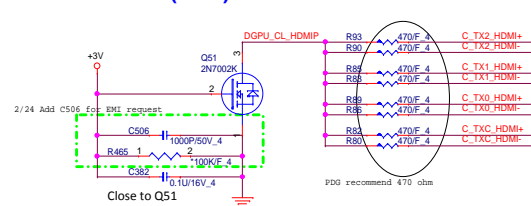
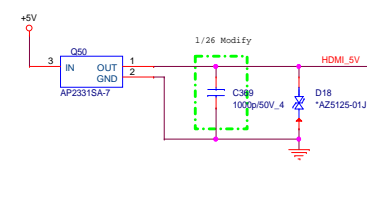
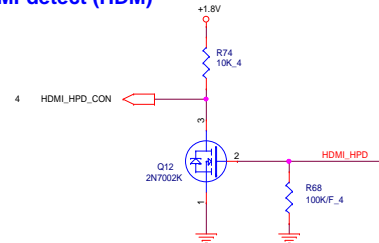


The diagram illustrates the timing for two sets of signals, MBCLK and MBCLK2. Each set consists of a clock signal and a data signal, both with a 4.7K 4 delay. The top set is connected to a +3V VPU1 supply, and the bottom set is connected to a +3V S5 supply.

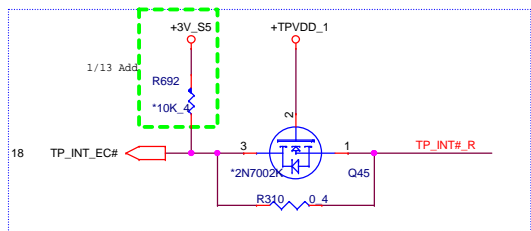
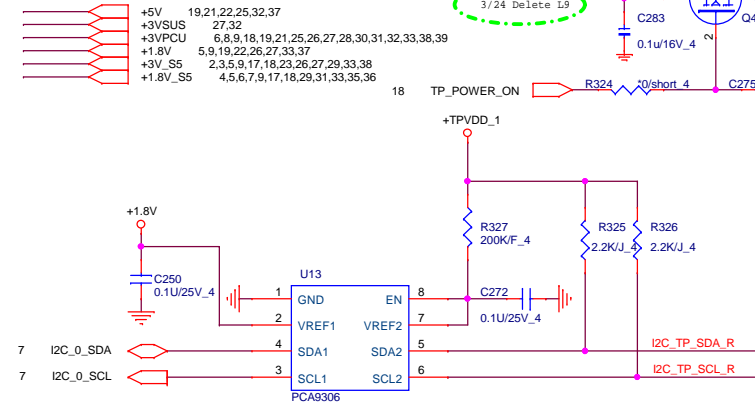


SM Bus 1	Battery
SM Bus 2	PCH/VGA
SM Bus 3	
SM Bus 4	

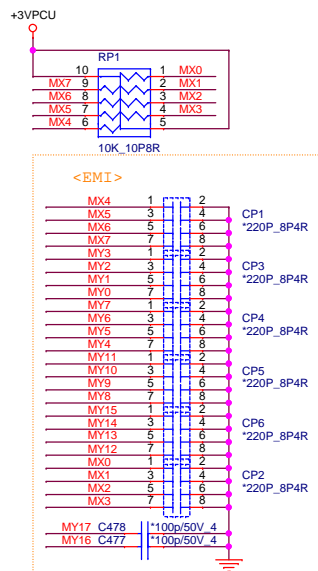


EDP Conn.**For ANGEL panel****CCD
Touch screen****Touch screen level shift I2C(reserve)****check touch panel if pull up****HDMI Conn.****HDMI SMBus Isolation****EMI (EMC)****HDMI-Level shift (HDM)****Close to HDMI connector****HDMI-detect (HDM)**

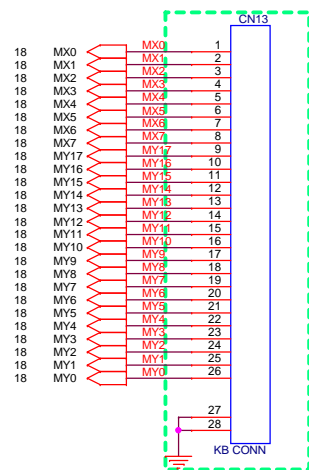
TOUCHPAD BOARD CONN (TPD) I2C/PS2 co-lay



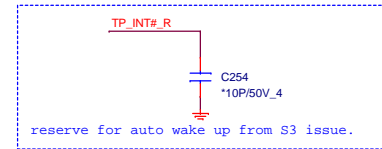
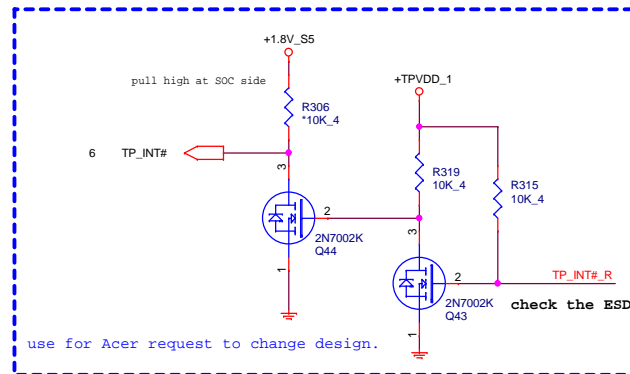
KEYBOARD (KBC)



SWAP KB nets 10/21

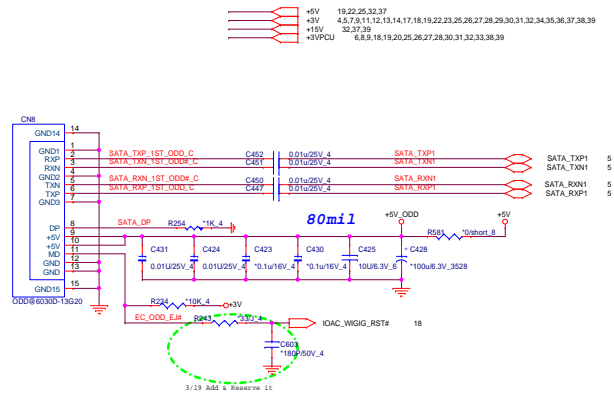


KB_BL LED (KBC)



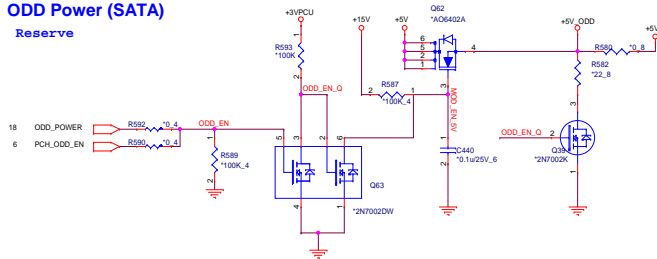
20

SATA ODD Connector

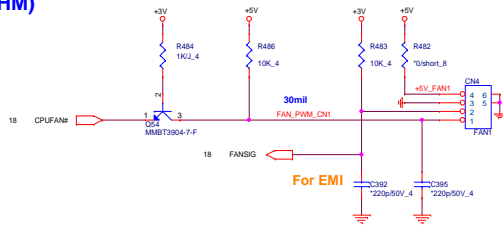


SATA ODD Re-driver

ODD Power (SATA) Reserve



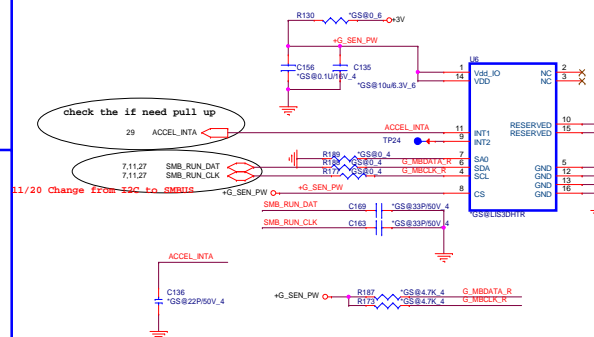
CPU FAN CTRL(THM)



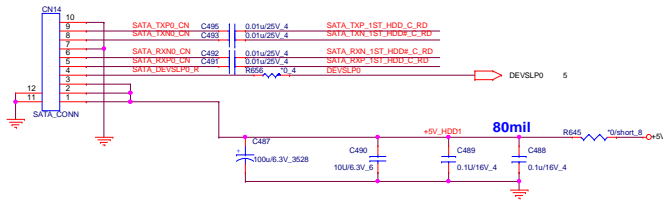
CPU Thermal sensor(THS) / MB Local TEMP

Reserve

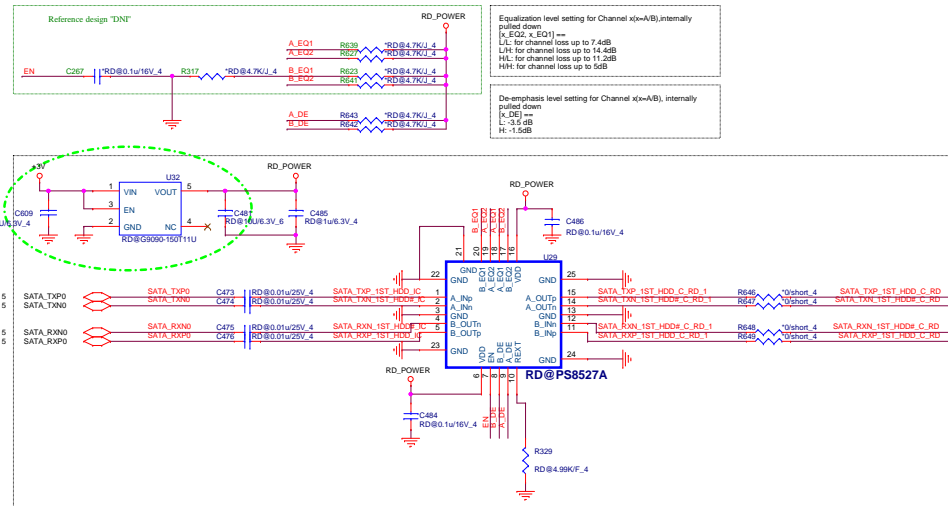
G-sensor



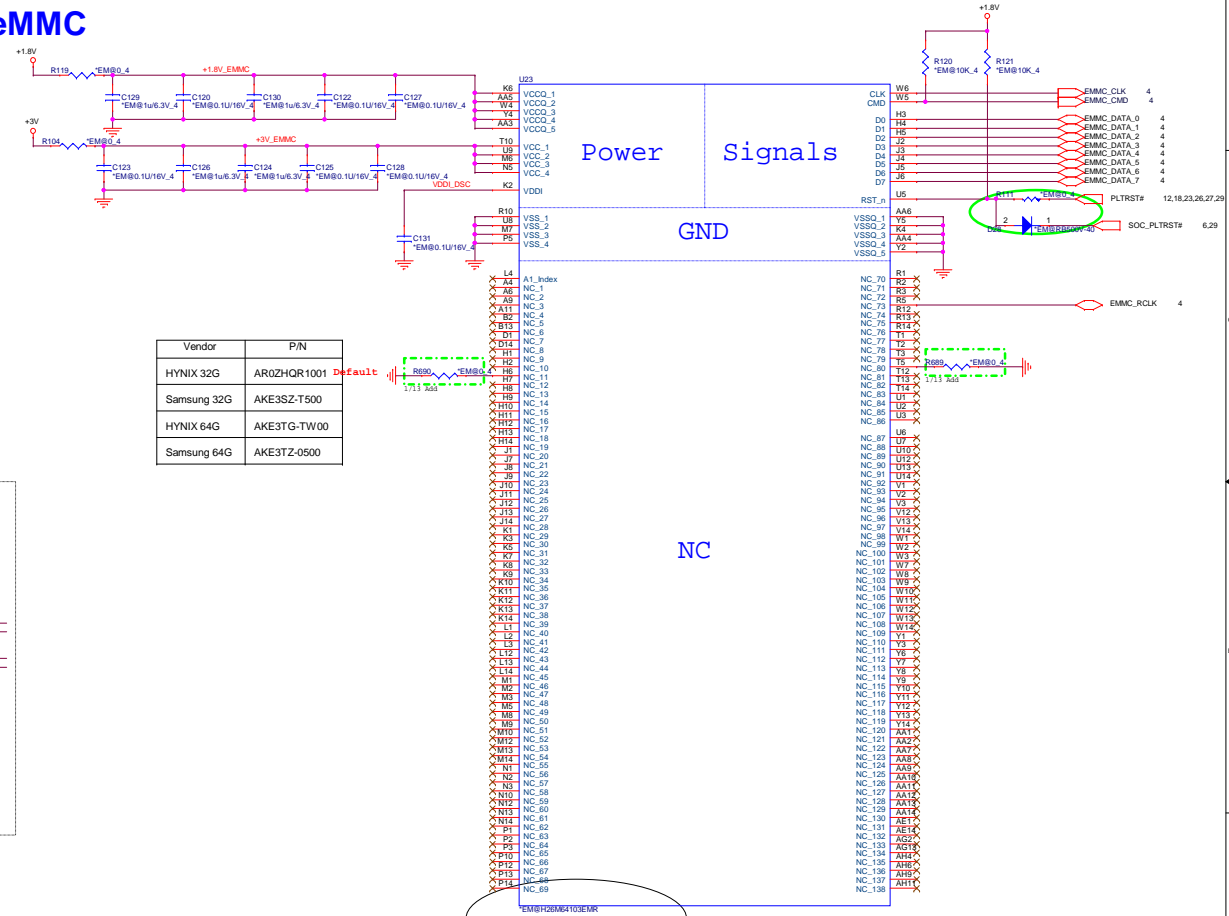
SATA HDD1 HDD1



HDD1 SATA Re-driver



eMMC

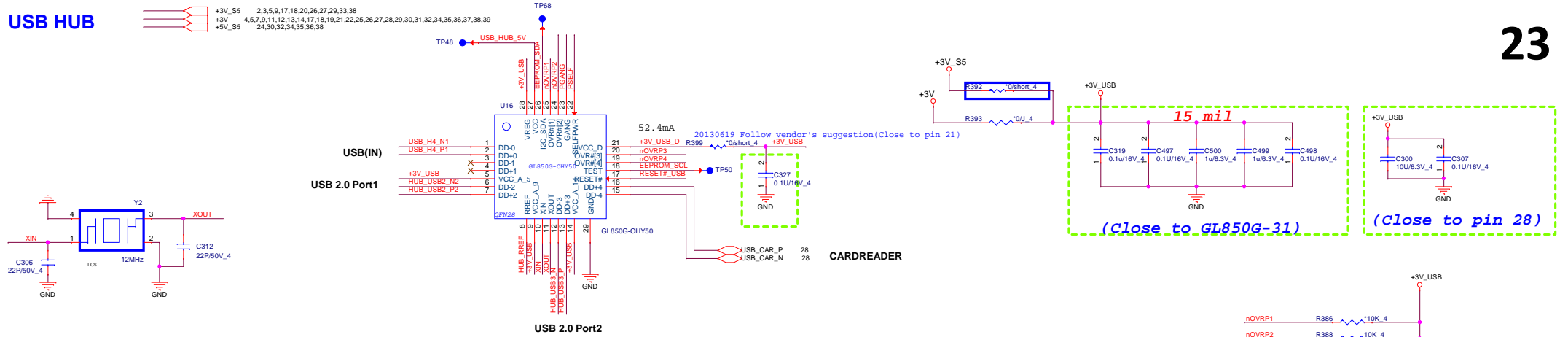


Vendor	P/N
HYNIX 32G	AR0ZHQR1001 Default
Samsung 32G	AKE3SZ-T500
HYNIX 64G	AKE3TG-TW00
Samsung 64G	AKE3TZ-0500

11/21 Change Footprint to "Zfpal69-samsung-kbmg000m-0_5a" by layout request.

USB HUB

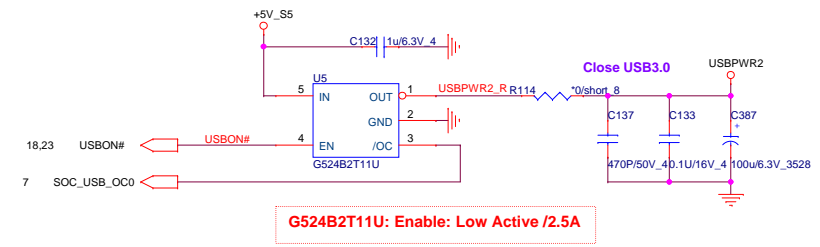
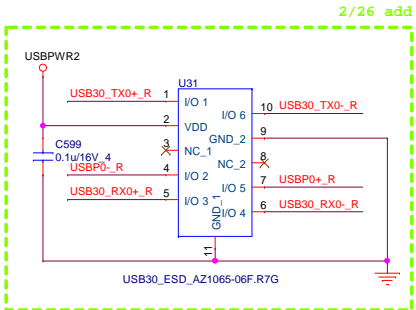
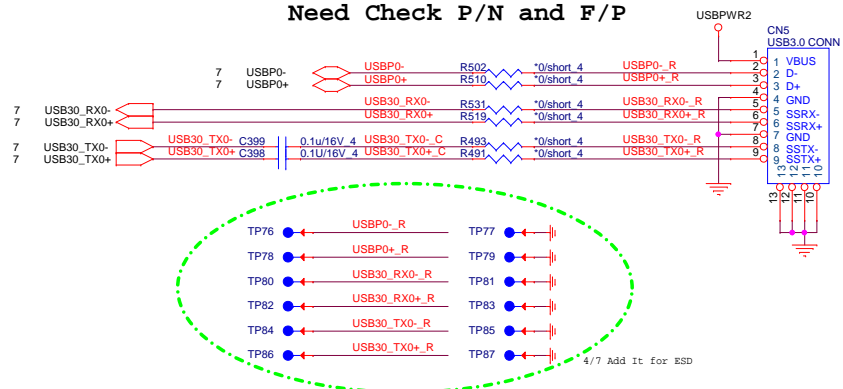
23



USB 3.0 Connector

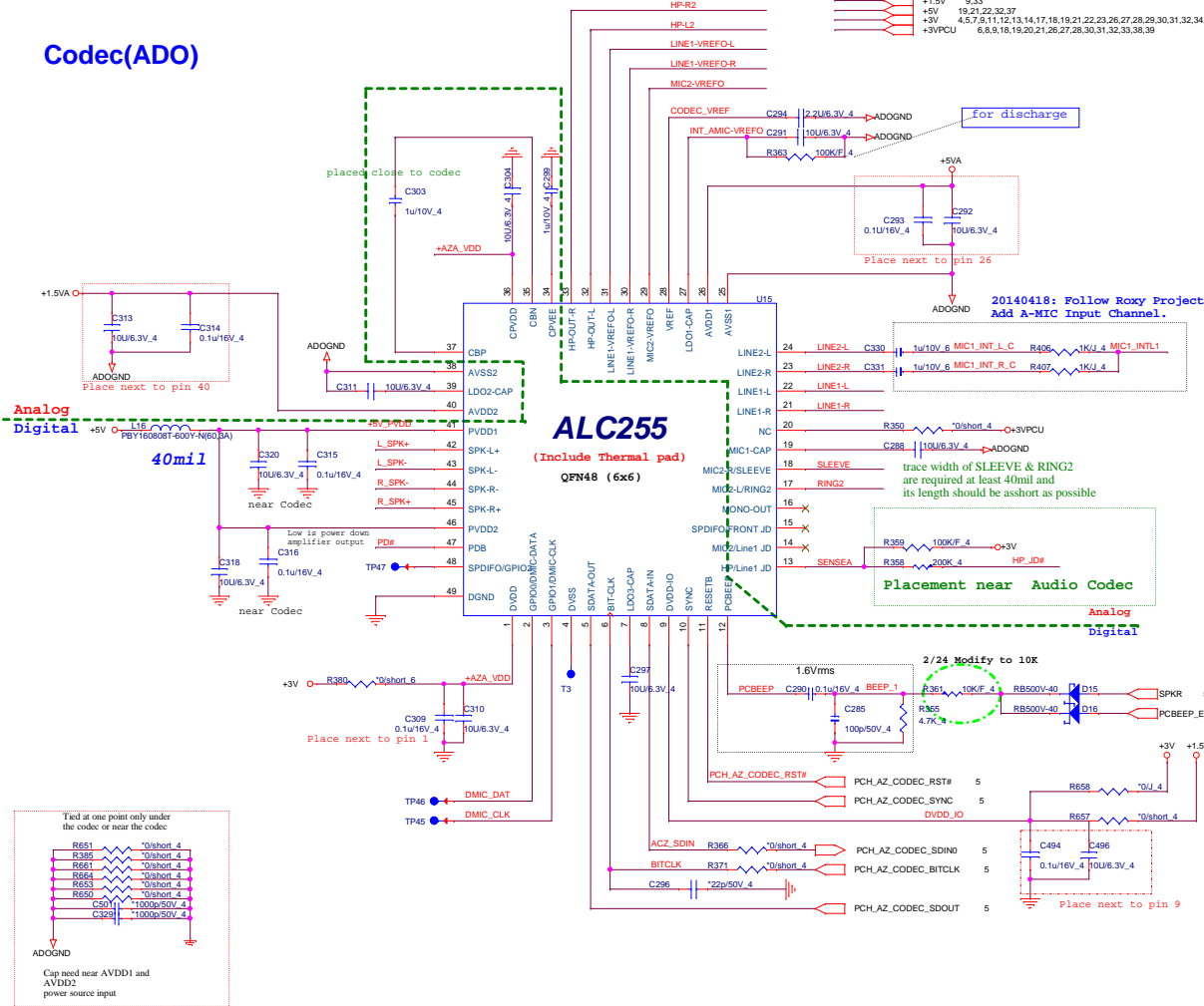
USB 3.0 Port1

Need Check P/N and F/P

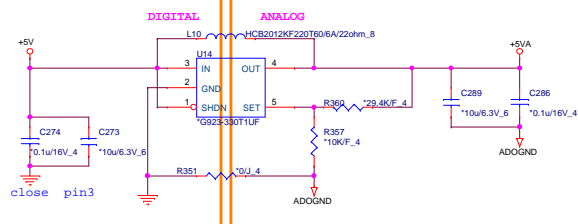


G524B2T11U: Enable: Low Active /2.5A

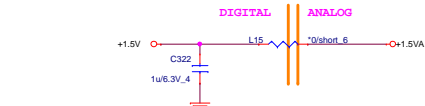
Codec(ADO)



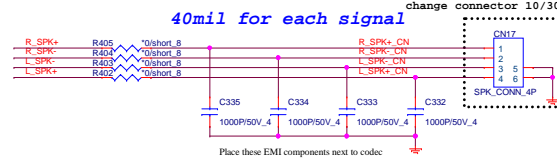
Codec PWR 5V(ADO)



Codec PWR 1.5V(ADO)

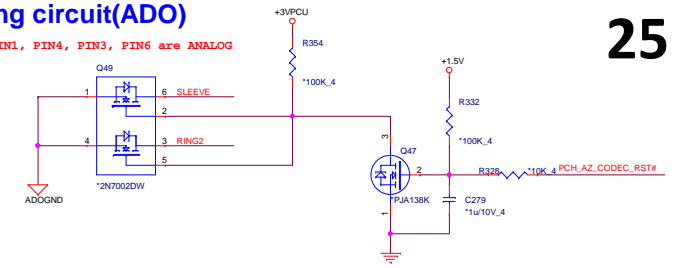


Internal Speaker

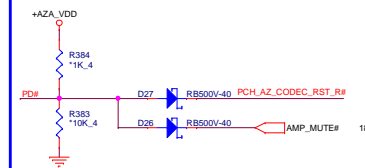


Grounding circuit(ADO)

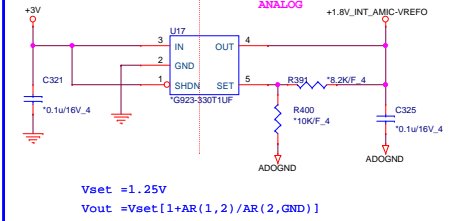
PIN1, PIN4, PIN3, PIN6 are ANALOG



Mute(ADO)

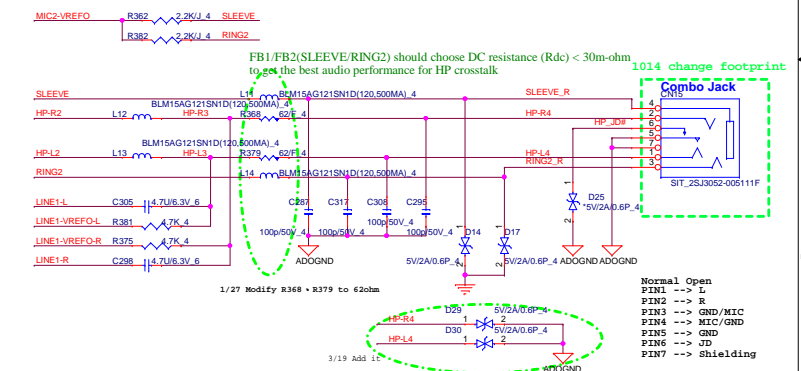


Power (ADO)



Demodulation Filter

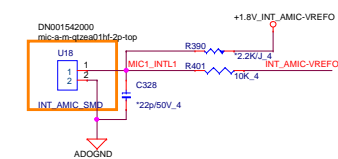
HEADPHONE/MIC/LINE combo (ADO)



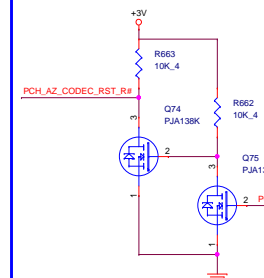
A-Mic

Analog-MIC

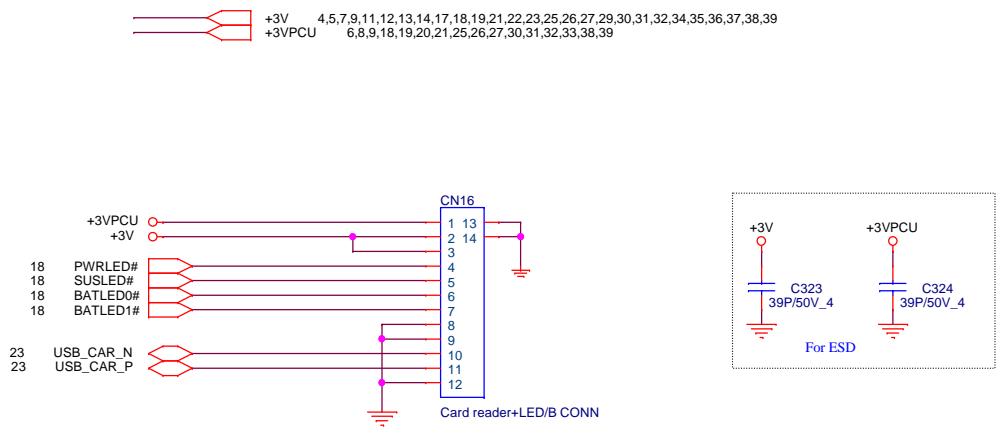
8/1 Change CN1 footprint to mic-a-m-qtzea01hf-2p-top .

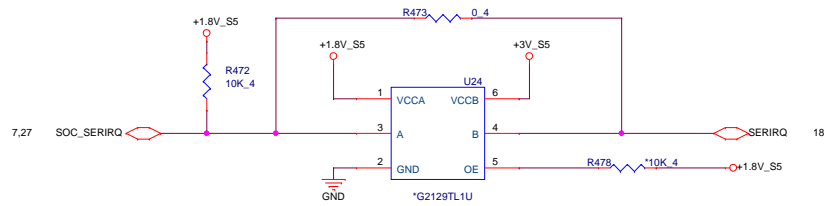


Level shift



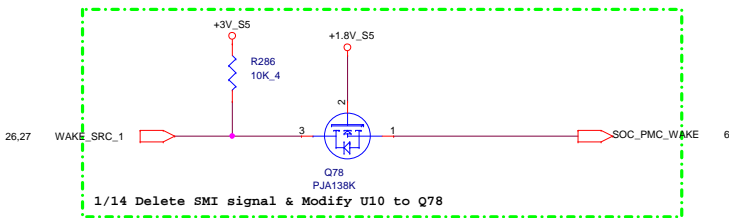
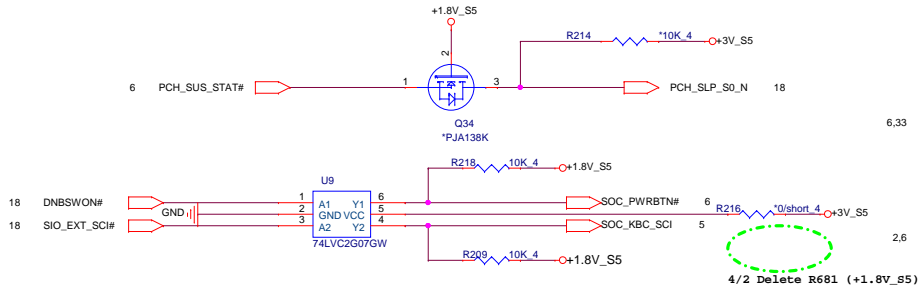
Card Reader+ LED/B Connector





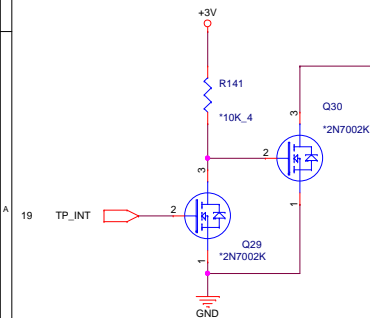
use 985LB1, SERIRQ just bypass.

+3V_S5 2,3,5,9,17,18,20,23,26,27,33,38
+3V 4,5,7,9,11,12,13,14,17,18,19,21,22,23,25,26,27,28,30,31,32,34,35,36,37,38,39
+1.8V_S5 4,5,6,7,9,17,18,20,31,33,35,36

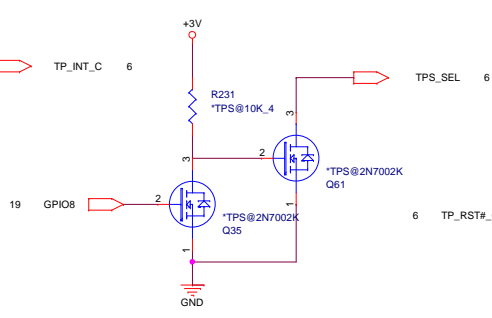


toTouch screen INT

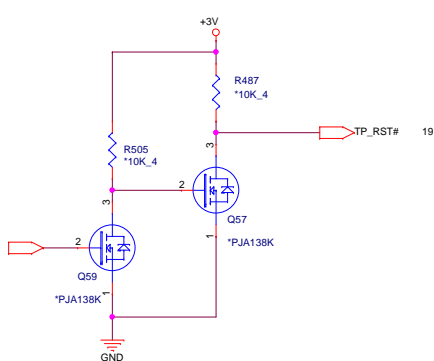
Touch Panel interrupt



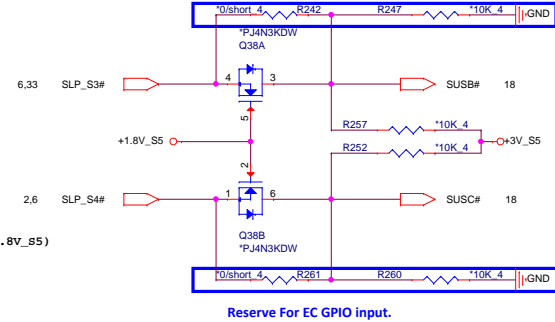
Touch screen detected



Touch screen reset

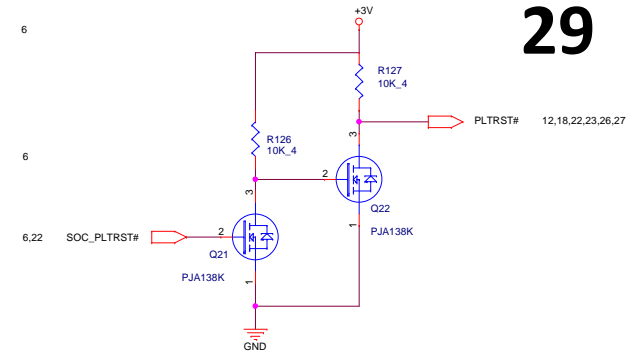
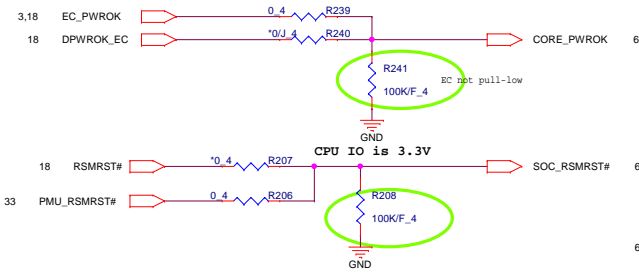


Reserve For EC GPIO input.



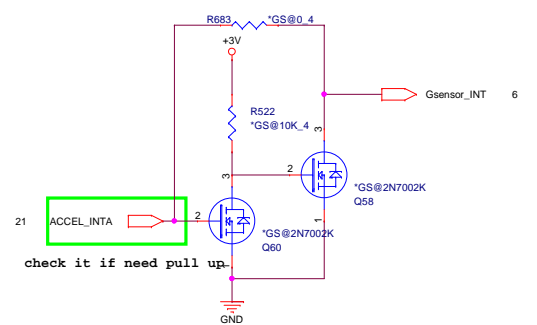
Reserve For EC GPIO input.

CPU IO is 3.3V



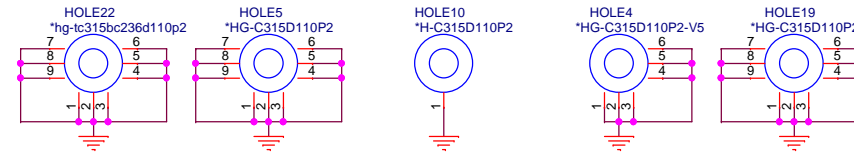
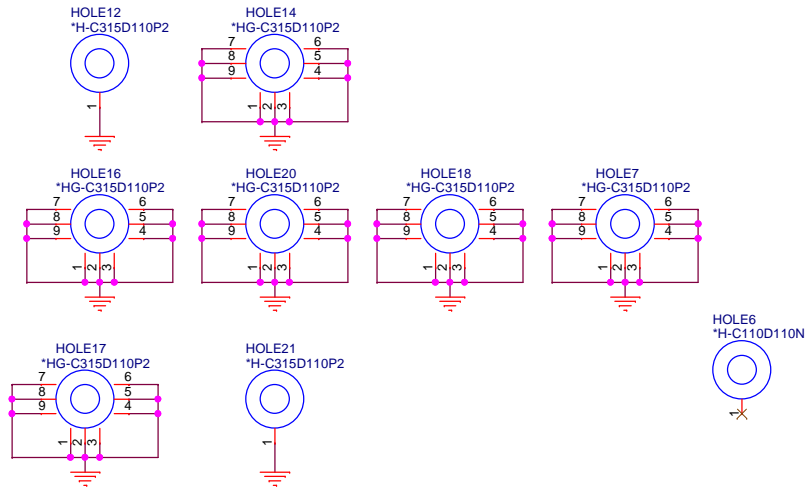
3/2 Delete WIFI_SUSCLK

G Sensor INT

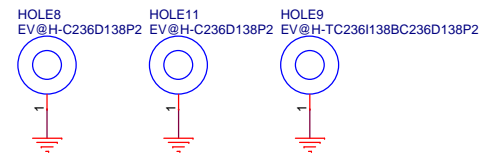


HOLE(OTH)

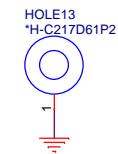
30



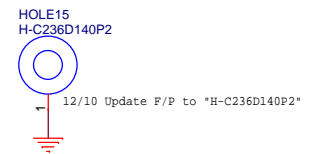
GPU nuts



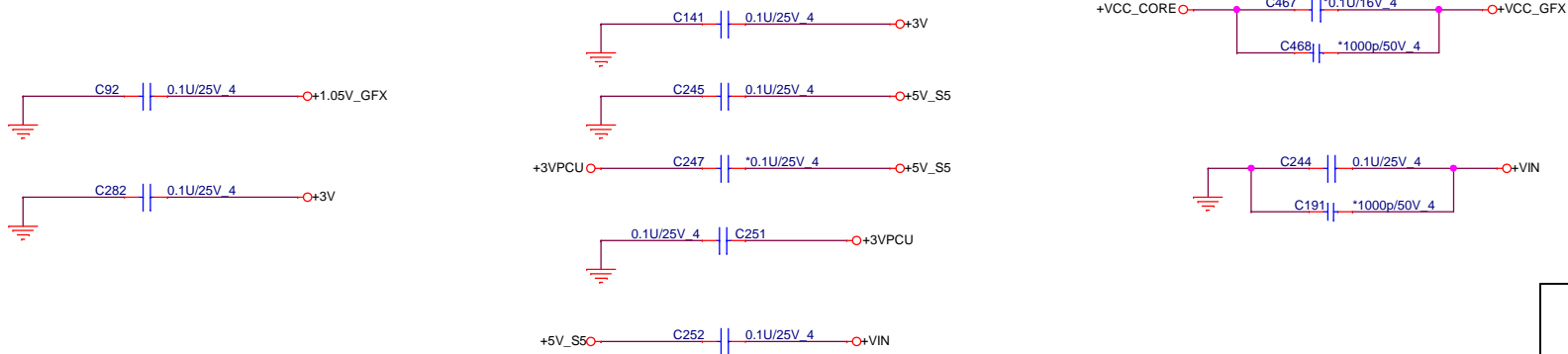
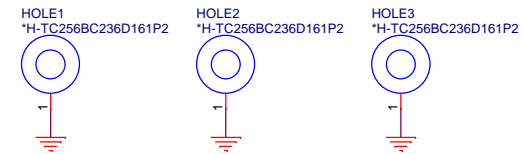
Mini card nuts



M.2 (NGFF)nuts



CPU nuts



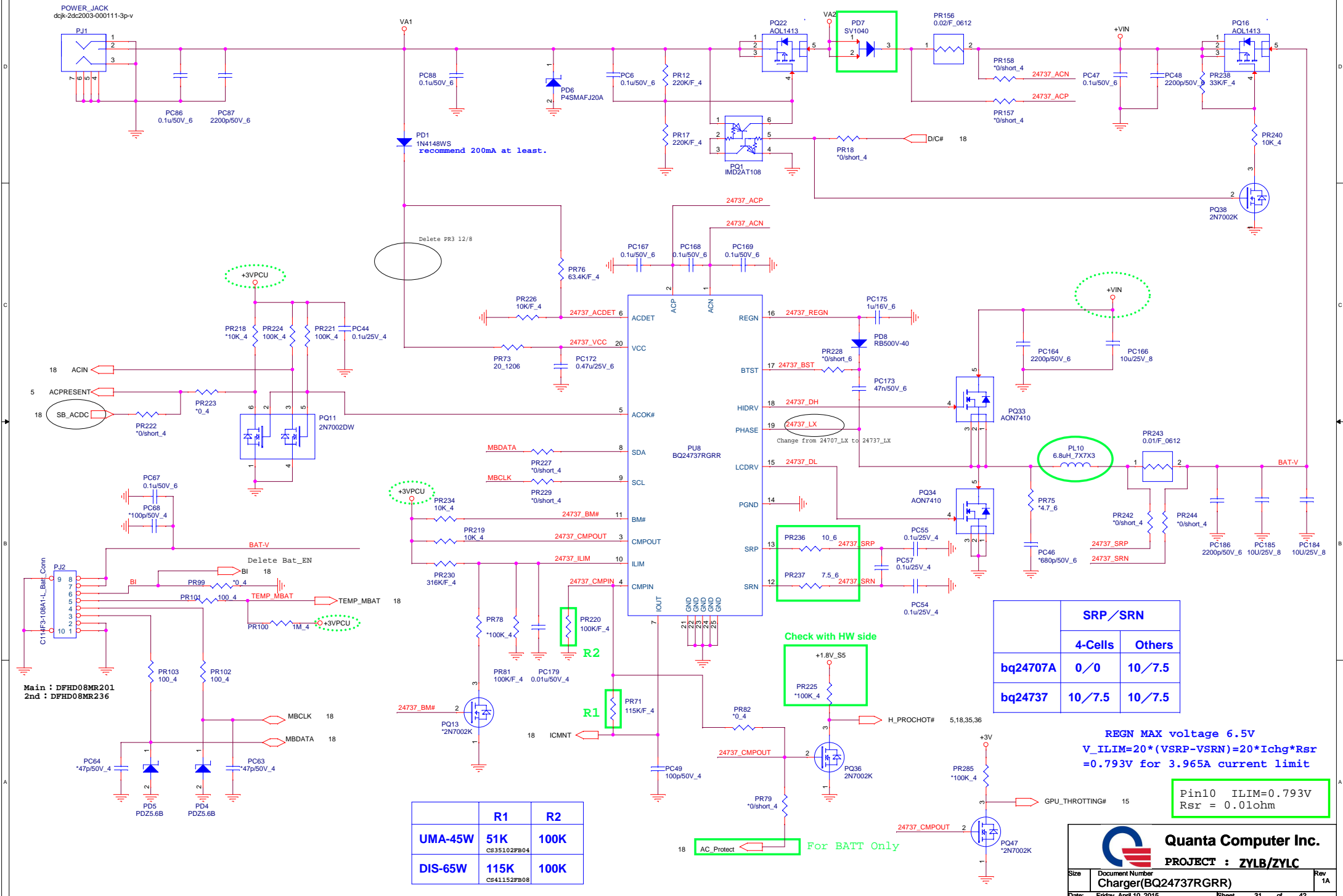
Quanta Computer Inc.

PROJECT : ZYLB/ZYLC

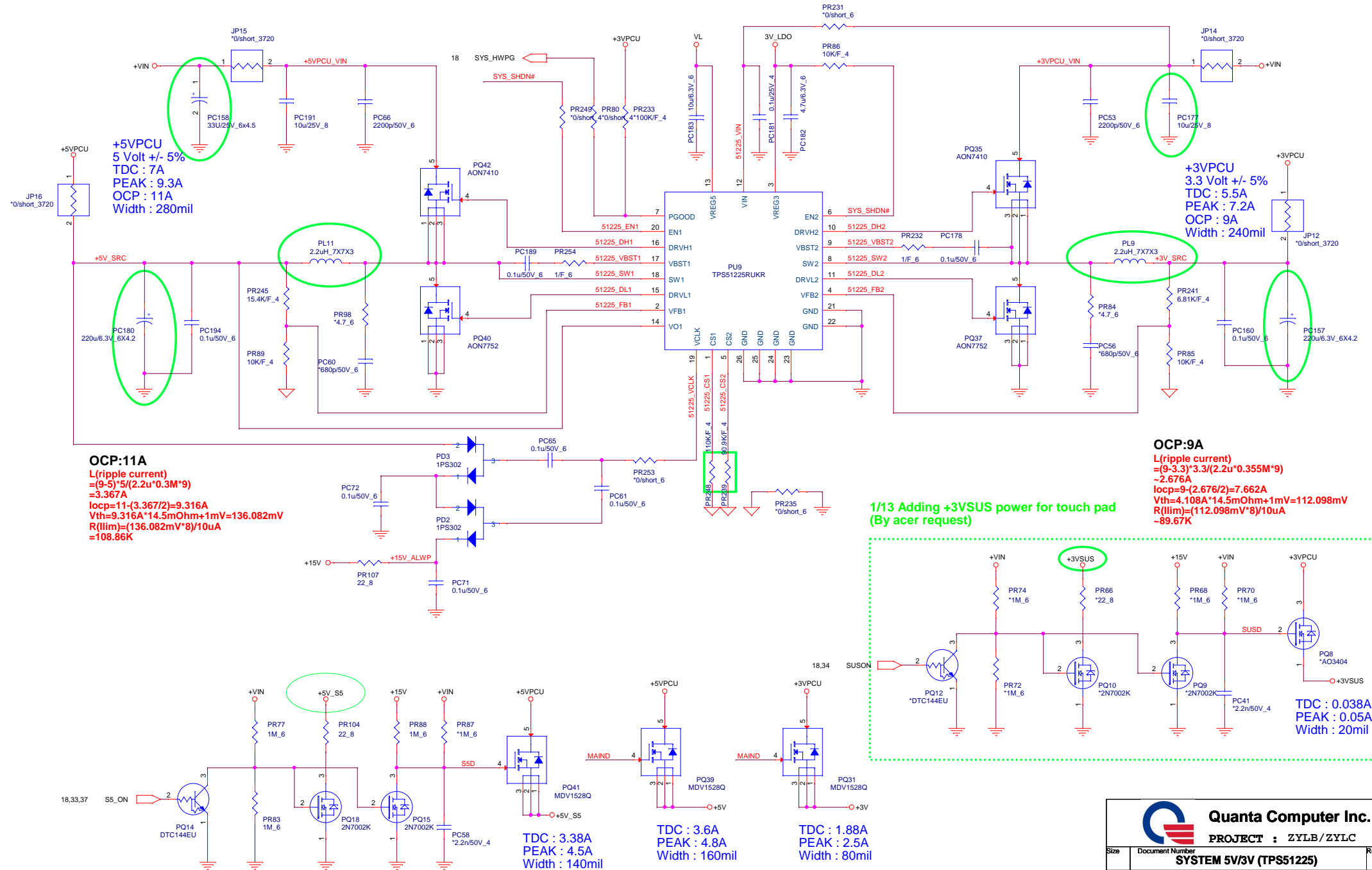
Size	Document Number	Rev
	USB BOARD CONN	1A
Date:	Friday, April 10, 2015	Sheet 30 of 42

DFPJ06MR015-- 65W
DFPJ03MR043--- 45W

31



MAIND → MAIND 33,37 SYS_SHDN# → SYS_SHDN# 37



Quanta Computer Inc.

PROJECT : ZYLB/ZYLC

Size Document Number **SYSTEM 5V/3V (TPS51225)** Rev 1A

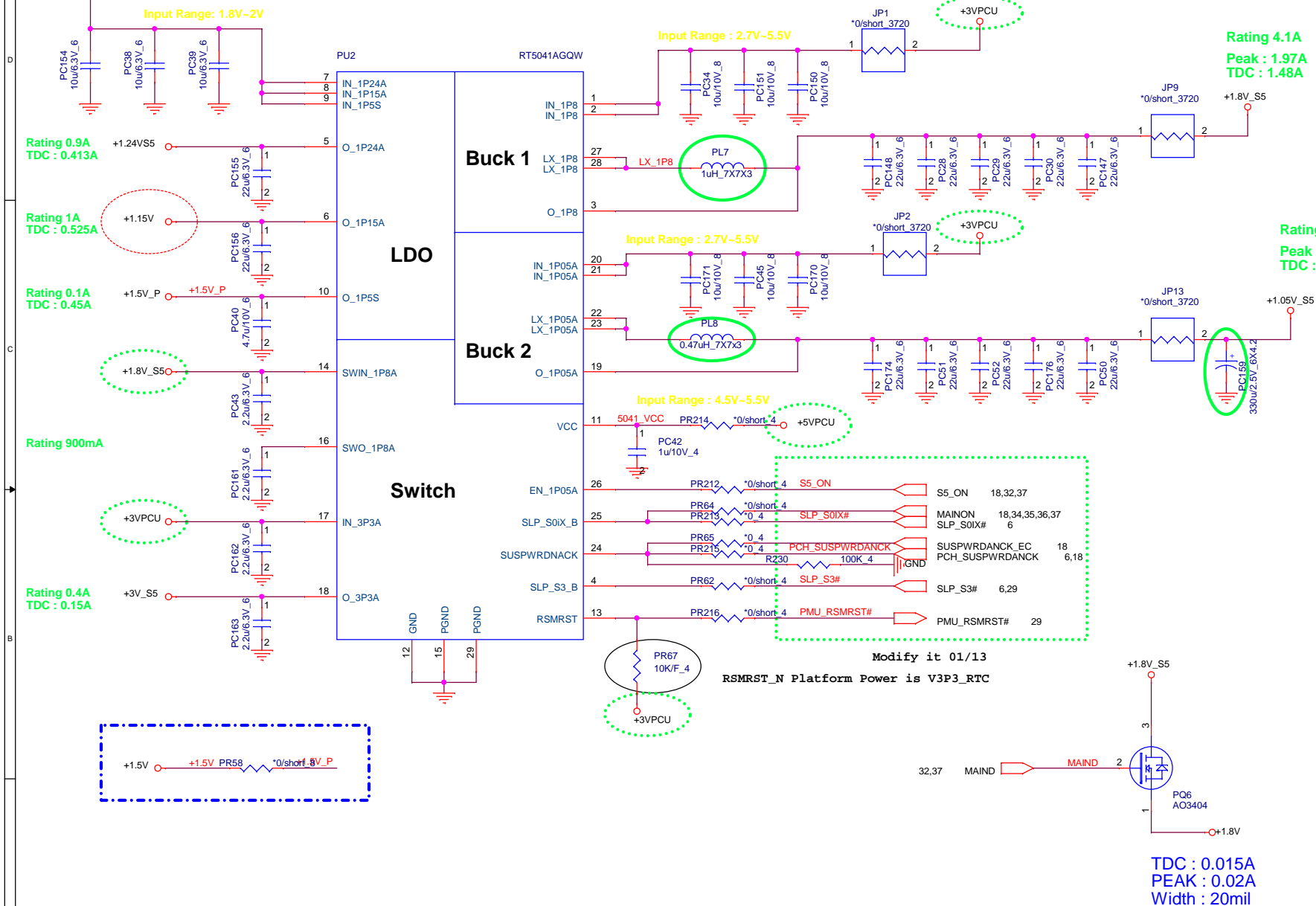
Date: Friday, April 10, 2015 Sheet 32 of 42

When SLP_S0iX_B=High, LDO_V1P15A_VOUT=1.15V
When SLP_S0iX_B=LOW, LDO_V1P15A_VOUT=0.75V

Rating 4.1A
Peak : 1.97A
TDC : 1.48A

Rating 4.4A
Peak : 5.4A
TDC : 4.05A

TDC : 0.015A
PEAK : 0.02A
Width : 20mil



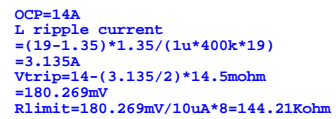
Quanta Computer Inc.

PROJECT : ZYLB/ZYLC

Size Custom Document Number
PMIC (RT5041AGQW)

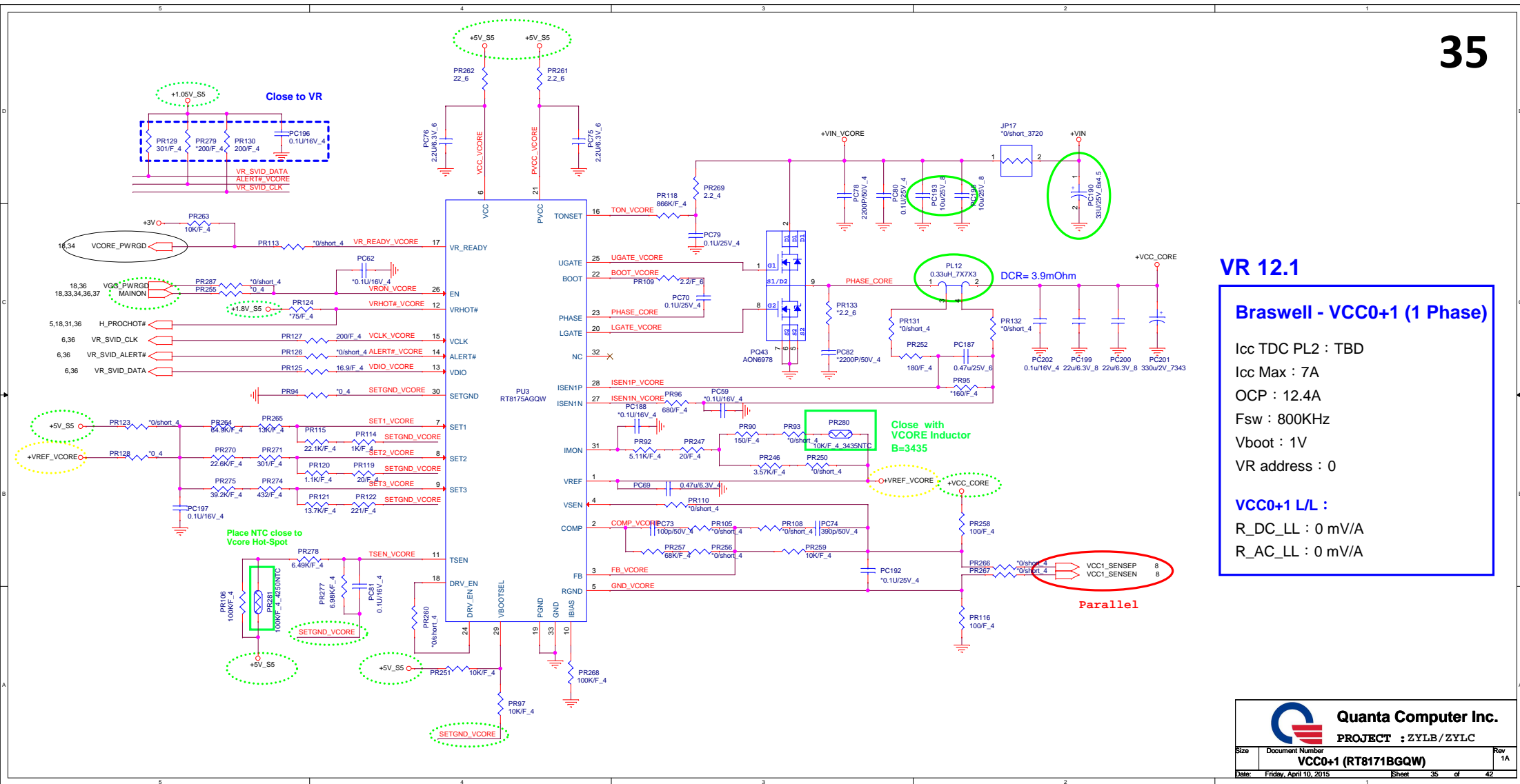
Rev 1A

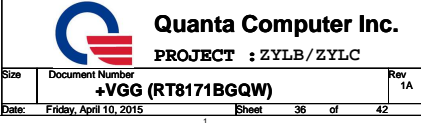
Date: Friday, April 10, 2015 Sheet 33 of 42



Fsw = 400KHz

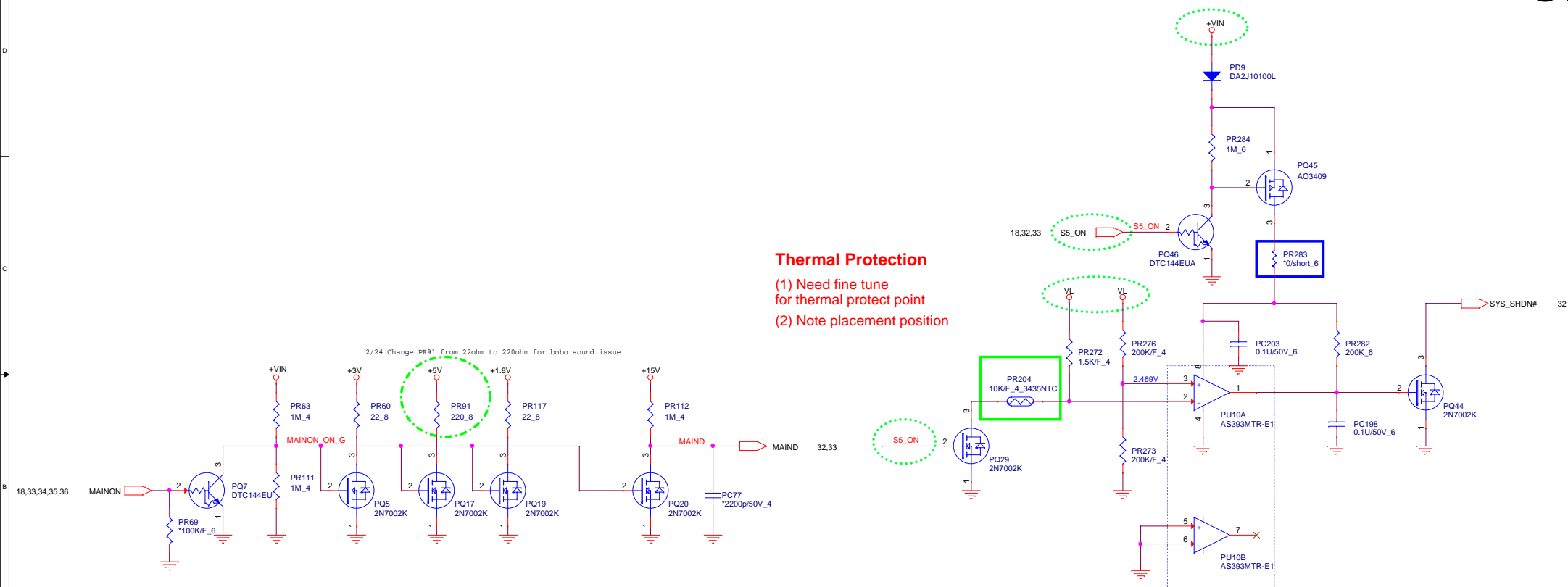
	S3	S5	+1.35VSUS	REF	VTT
S0	1	1	ON	ON	ON
S3 (mainon off)	0	1	ON	ON	OFF
S4/S5	0	0	OFF	OFF	OFF





Thermal Protection

- (1) Need fine tune for thermal protect point
- (2) Note placement position

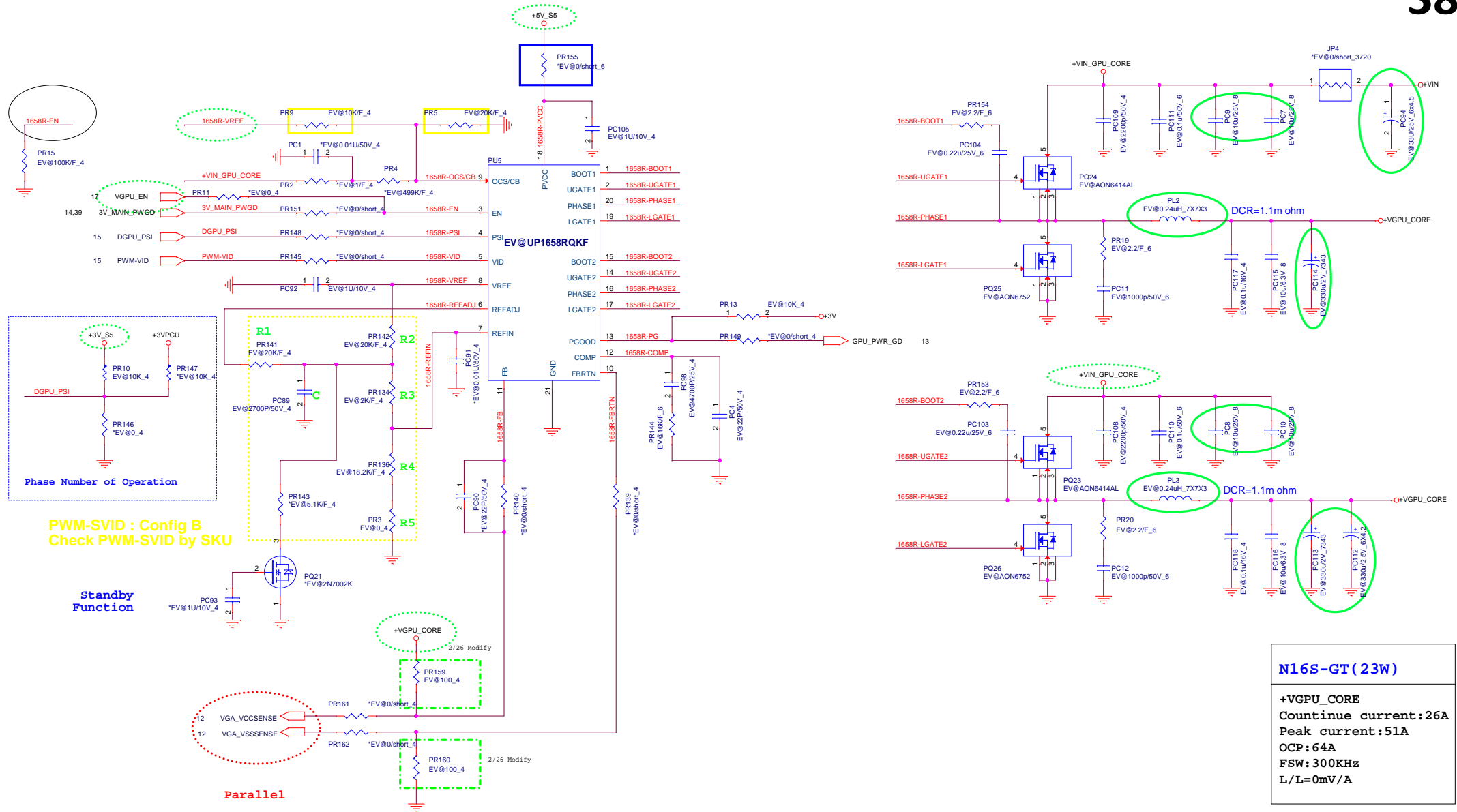


Quanta Computer Inc.

PROJECT : ZYLB/ZYLC

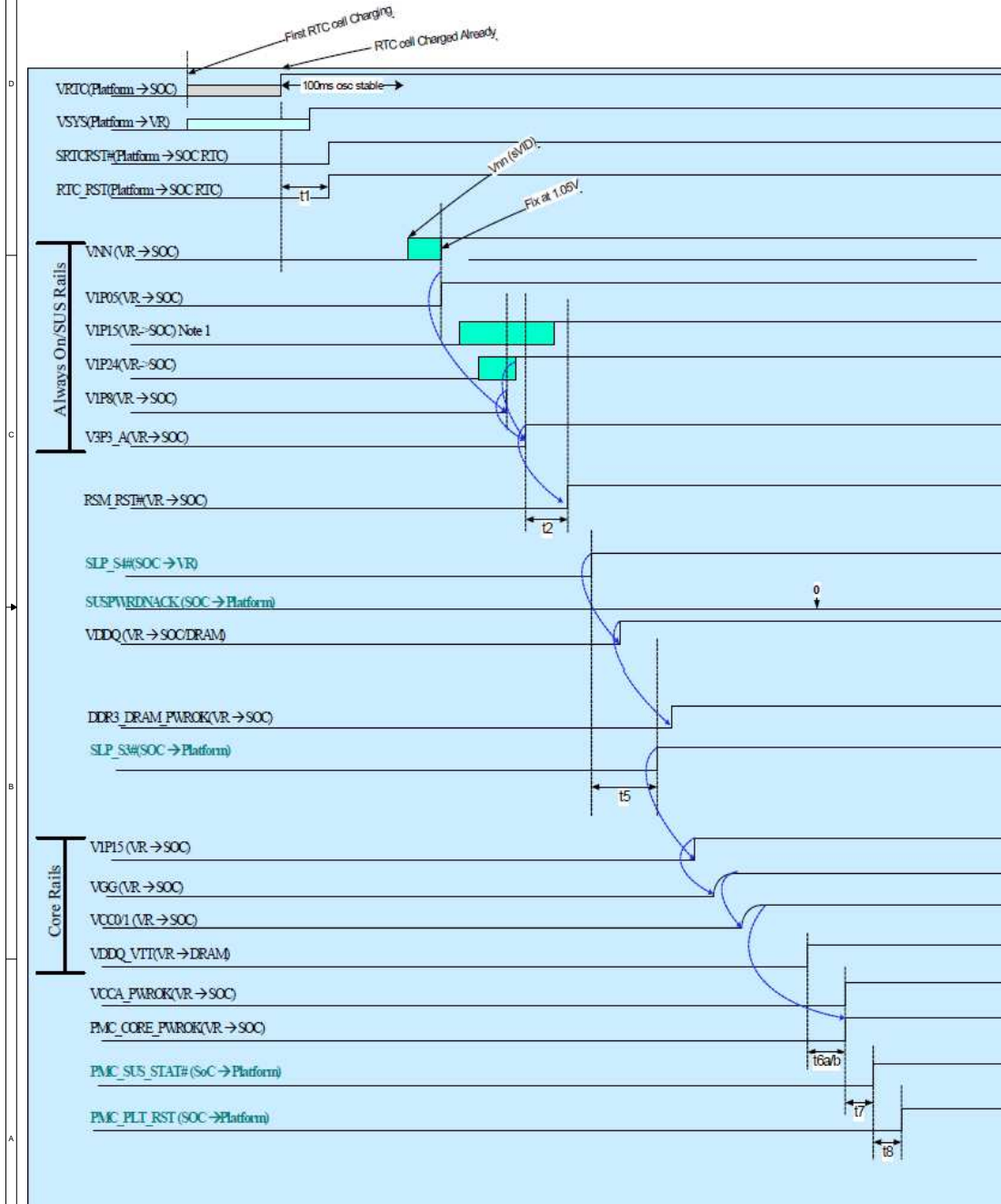
Size Document Number **Thermal / Discharge** Rev 1A

Date: Friday, April 10, 2015 Sheet 37 of 42



Braswell S4/S5 to S0 (Power Up) Sequence

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Platform Power Up Timing (G3 to S0)

Parameter	Description	Minimum	Maximum	Units
t1	RTC_VCC to RTC_RST# de-assertion	9	-	ms
t2	V3P3A (SUS Rails) valid to RSMRST# de-assertion (t1 still applies in applications without RTC battery)	10	-	μs
t3	RSMRST# to Internal RTC Clock stable ²	95	-	ms
t4	Internal RTC Clock stable to PMC_SUSCLK[0] toggling	5	-	ms
t5	PMU_SLP_S4# de-assertion to PMU_SLP_S3# de-assertion	26	-	μs
t6a	Core well stable to DDR3_DRAM_PWROK and PMC_CORE_PWROK assertion (NO PCIe* devices)	10	-	ms
t6b	Core well stable to DRAM_CORE_PWROK and PMC_CORE_PWROK assertion (for power rails needed by PCIe* devices)	99	-	ms
t7	PMC_CORE_PWROK to PMC_SUS_STAT#	1	-	ms
t8	PMC_SUS_STAT# de-assertion to PMC_PLTRST# de-assertion	60	-	us

Model	REV	CHANGE LIST		ZYLБ/ZYLC MB		
ZYLB MB	REV.A	1	2014/11/28 Add R4213 & delete R689 to follow Intel circuit (page 6)	Page	From	To
				1		3A
		1	2014/12/03 Change H0lc30 footprint to "H-C236D142P2" (page 30)	2		3A
		2	2014/12/03 Change R4192 & R350 from short0402 to RC0402 (page 22)	3		3A
				4		3A
		1	2014/12/04 Delete M_A_MONIP & M_A_MONIN (page 2)	5		3A
				6		3A
		1	2014/12/08 Delete PR3 (page 31)	7		3A
	REV.B			8		3A
		1	2014/12/10 Change H0lc30 footprint to "H-C236D140P2" (page 30)	9		3A
				10		3A
		1	2014/12/16 Change R361 from 47K to 22K (CS32202FB18) & R290 from 1u to 0.1uF(CH4103K1B08) (page 25)	11		3A
				12		3A
		1	2014/12/29 Reserve R669 for EMMC 5.0 device (page 4)	13		3A
		2	2014/12/29 Change Q65 pin2 to +1.8V (page 4)	14		3A
		3	2014/12/29 Add Q77 for "PCIE_CLKREQ0_VGA#" (page 12)	15		3A
		4	2014/12/29 Add "SOC_VCCAPWROK" Schematic (page 3)	16		3A
		5	2014/12/29 Change U6 pin1 & pin14 to +3V (page 21)	17		3A
		6	2014/12/29 Change Q28 pin2 to +1.8V (page 26)	18		3A
		7	2014/12/29 Change U9 pin5 to +3V_S5 (page 26)	19		3A
		8	2014/12/29 Add R683 for reserve (page 26)	20		3A
		9	2014/12/29 Stuff R477 · R470 & Change R470 to 3.3K (page 26)	21		3A
		10	2014/12/29 Change debug port to NGFF CONN(CN9) (page 27)	22		3A
		11	2014/12/29 Delete C456 · C433 · C461 & Add C503 (page 23)	23		3A
		12	2014/12/29 Delete "BIOS_STRAP" (page 5)	24		3A
		13	2014/12/29 Add "GPU_THROTTLING#" Schematic (page 15 · 31)	25		3A
	REV.C	1	2015/01/07 Add Hynix HSTC4G63CFR-N0C strap (page 15)	26		3A
				27		3A
		1	2015/01/27 Un-stuff Q55 · R489 · R485 · R532 · R656 (page 5)	28		3A
		2	2015/01/27 Un-stuff R563 · R498 · R196 · R503 & delete R178 (page 6)	29		3A
		3	2015/01/27 Change Board ID4 to M/B ID strap pin (Stuff R542 & Un-stuff R543) (page 6)	30		3A
		4	2015/01/27 Un-stuff R296 (page 7)	31		3A
		5	2015/01/27 Change SMB_SOC_DATA& CLK design (Delete Q19 · R94 · R95 · R100 · D4 · D5 · Add U30 · C505 · C504 · R686 · R687 · R688) (page 7)	32		3A
		6	2015/01/27 Un-stuff R535 (page 9)	33		3A
		7	2015/01/27 Un-stuff R171 (page 11)	34		3A
		8	2015/01/27 Un-stuff GC6 parts (U2 · C21 · R77 · R79 · R26 · R30 · R24 · R29 · Q15 · Q18 · R87 · R91 · R23 · R439 · R437) (page 12 · 15 · 17)	35		3A
		9	2015/01/27 Swap CPUFAN# & THRM_MOINTOR · Un-stuff R243 · R244 · R228 · R279 · Change R280 to 10ohm (page 18)	36		3A
		10	2015/01/27 Un-stuff Touch Screen parts (R413 · R414 · R14) · Change R6 to 1K ohm (page 19)	37		3A
		11	2015/01/27 Delete L7 · Stuff Q46 · R324 & Un-stuff R343 for Touchpad power control (page 20)	38		3A
		12	2015/01/27 Un-Stuff IOAC parts (R131 · R140 · R134 · Q23 · Q37 · R263) (page 26 · 27)	39		3A
		13	2015/01/27 Un-Stuff R496 · R289 & Stuff Q56 · Q40 for leakage current issue (page 26 · 27)			
		14	2015/01/27 delete S0IX level-shift (Q64 · R594) & un-stuff Q34 · R214 for unuse (page 29)			
		15	2015/01/27 delete SMI signal (U10 · R235 · R232) & modify level-shift to Q78 (page 29)			
		16	2015/01/27 Un-stuff touch-screen level-shift Q29 · Q30 · Q35 · Q61 · Q57 · Q59 · R141 · R231 · R487 · R505 (page 29)			
		17	2015/01/27 Un-stuff PR215 & stuff R230 for powe design (page 33)			
		18	2015/01/27 Un-stuff PR210 · PR255 · stuff PR286 · PR287 to follow Intel power-on sequence (page 34 · 35)			
		19	2015/01/27 Un-stuff U26 · C407 · R546 for unuse (page 29)			
		20	2015/01/27 Stuff Q72 · R652 · R620 for EC request (page 6)			
		21	2015/01/27 Stuff R465 · C369 for EMI request (page 19)			
		22	2015/01/27 Stuff C117 & change C268 · C270 · C265 · C277 · C276 · C264 · C385 · C113 · C177 · C173 · C384 to 22u/6.3V for Intel suggest (page 8)			
		23	2015/01/27 Change R468 to 10K to 1K (page 17)			
		24	2015/01/27 Change PU3/PU7 to RT8175AGQW · change PR262/PR27 to 22ohm · PR265 to 13K · PR114 to 1K · PC73 to 100P · PL1 to 1uH · un-stuff PR94/PR185 for power requesr (page 35 · 36 ·)			
		25	2015/01/27 Change R368/379 to 62ohm for vendor suggest (page 25)			
	REV.D	1	2015/02/05 Change C416/C419 from 18pF to 15pF for vendor suggest (page 6)			
		2	2015/02/05 Change C356/C357 from 10pF to 12pF for vendor suggest (page 14)			
		1	2015/02/24 Stuff D14 · D17 · D25 for ESD (page 25)			
		2	2015/02/24 Change HE1 source to AL009132001 (page 21)			
		3	2015/02/24 Change R361 from 22K to 10K for noise issue (page 25)			
		4	2015/02/24 Add C506 & change R465 to *100K/F_4 for EMI request (page 19)			
		5	2015/02/24 Stuff D21 · D22 · D23 · D24 for ESD (page 23)			
		6	2015/02/24 Change PR91 from 22ohm to 220ohm for Bobo sound issue (page 37)			

Model	REV	CHANGE LIST	ZYLБ/ZYLC MB				
ZYLБ MB	REV.D	1 2015/02/25 Change R442 from 4.99K to 45.3K for vendor suggest(support Gen 3) (page 15)	Page 1	From	To 3A		
		1 2015/02/26 Change C114/C115 from 10pF to 12pF for vendor suggest (page 26)	2		3A		
		2 2015/02/26 Add USB3.0 ESD component U31 & C599 (page 24)	3		3A		
		3 2015/02/26 Modify PQ2 to PJA138K(BAM138K0001) & un-stuff PR51 (page 39)	4		3A		
		4 2015/02/26 Modify PR159/PR160 from 0ohm to 100ohm (page 38)	5		3A		
		5 2015/02/26 Add R693(reserve) & R694 for current leakage issue (page 18)	6		3A		
			7		3A		
			8		3A		
			9		3A		
			10		3A		
		1 2015/03/2 Delete Wifi_SUSCLK schematic(U26・R544・C407・R546) & add TP75 for vendor request (page 6・27・29)	11		3A		
			12		3A		
		1 2015/03/3 Add Board ID0 strap (R695・R696) (page 6)	13		3A		
		2 2015/03/3 Add R697 & Change C1 to 180P/50V for ESD (page 21)	14		3A		
		3 2015/03/03 Un-Stuff Q56 & Stuff R496 (page 26)	15		3A		
			16		3A		
		1 2015/03/04 Un-Stuff R528・R527・R540・R539 (page 7)	17		3A		
		2 2015/03/04 Un-Stuff Q40・R291 (page 27)	18		3A		
		3 2015/03/04 Change R687・R688 from 2.2K to 4.7K (page 7)	19		3A		
		4 2015/03/04 Change D8 to RB500V-40 (BCRB500VZ29) (page 18)	20		3A		
		21		3A			
		22		3A			
		23		3A			
	1 2015/03/06 Change PU9 P/N from AL051225000 to AL051225003 for PDC request (page 32)	24		3A			
		25		3A			
	1 2015/03/06 Change L11・L12・L13・L14 to CX5AG121002 for PDC request (page 25)	26		3A			
		27		3A			
	REV.E	1 2015/03/19 Modify R280 to close CN12 & add C600・R698・C601 for ESD (page 20)	28		3A		
		2 2015/03/19 Add R699 & C602 for ESD (page 27)	29		3A		
		3 2015/03/19 Modify R243 to close CN8 & add C603・R702・C607 for ESD (page 21)	30		3A		
		4 2015/03/19 Add R700・R701・C604・C605・C606 for ESD (page 19)	31		3A		
		5 2015/03/19 Delete R253 (page 18)	32		3A		
		6 2015/03/19 Add SPAD1-SPAD10 for ESD (page 30)	33		3A		
		7 2015/03/19 Add D29・D30 & Change D14・D17・D25 to BCPJSD05Z06 for ESD (page 25)	34		3A		
		8 2015/03/19 Change D21-D24 to BCPJSD05Z06 for ESD (page 23)	35		3A		
		9 2015/03/19 Change R161 connect from +3V to +3V_S5 for current leakage issue (page 23)	36		3A		
		10 2015/03/19 Change some parts from 0 ohm to shortpad	37		3A		
			38		3A		
			39		3A		
		1 2015/03/24 Delete L9 (page 20)					
		1 2015/04/2 Add & Reserve C608 for vendor suggest (page 26)					
		2 2015/04/2 Delete R681 (+1.8V_S5) (page 29)					
		1 2015/04/07 Delete SPAD1-SPAD10 (page 30) & Add TP76-TP95 for ESD (page 23 &24)					